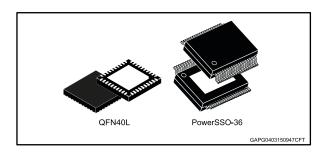
L99SM81V



Programmable stepper motor driver for automotive applications with micro-stepping and stall detection

Datasheet - Production data



Features



- AEC-Q100 qualified
- Stepper motor driver with up to 1.35 A current capability
- Programmable Step mode:
 - Full step, Half step, Mini step, 1/8 Micro step, 1/16 Micro step
- Current regulation by integrated PWM control with fully integrated current sensing
- Equivalent 10 bit resolution on current regulation loop:
 - Two 4-bit programmable full scale current amplitudes: one for RUN and one for HOLD mode
 - 6-bit DAC for reference current generation (whatever programmed full scale amplitude)
- 4 programmable decay modes:
 - Slow-mode, mixed-mode and 2x automatically selected decay-modes
- 3x programmable inputs for direct control of step clock, direction, hold and step modes
- 1x programmable analog output for T_j measurement or band-gap reference
- 2x programmable digital outputs for internally generated PWM ON duty cycles,

- error signals, coils voltage measurement synchronization signals
- Programmable MOSFETs switching speed: four options for EMC and power dissipation trade-off optimization
- PWM frequency wobbling for reduction of conducted EM energy
- Outputs protection and diagnosis (open load, short to battery, short to GND)
- Integrated ADC for coil voltage measurement and stall detection
- 5 V low drop voltage regulator short-circuit protected
- Very low current consumption in standby mode (typ. 10 μA)
- Thermal warning and shutdown
- ST SPI 4.1 interface for control and diagnostics

Applications

Bipolar 2 phase stepper motor driver for automotive applications like adaptive front light systems or projectors for head-up displaying

Description

The L99SM81V is an automotive grade integrated driver for bipolar two-phase stepper motors capable of current controlled microstepping with programmable amplitude. The device features a 5 V voltage regulator to supply external sensors.

The integrated Serial Peripheral Interface (SPI) makes it possible to adjust device parameters, control all operating modes and read out diagnostic information. Digital I/Os are also optionally usable for more flexible and reliable application control.

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1 Block diagram and pin description

Figure 1: Block diagram (QFN40L)

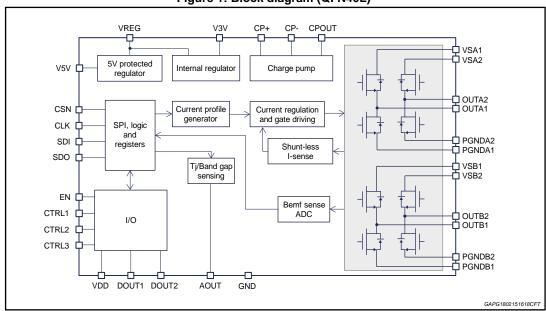


Figure 2: Block diagram (PowerSSO-36)

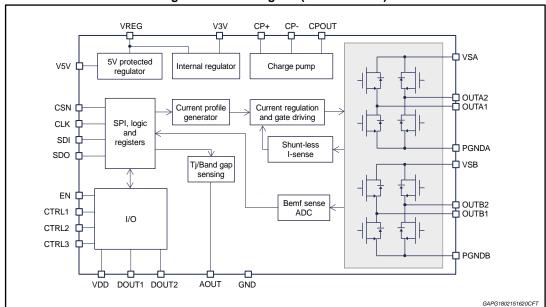


Figure 3: QFN40 pin connections (top view)

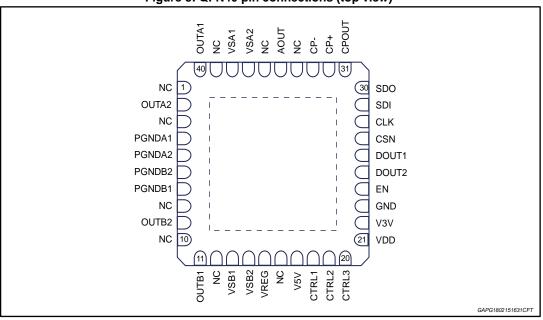


Figure 4: PSSO36 pin connections (top view)

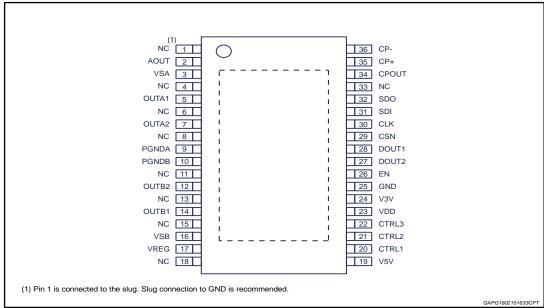


Table 1: Pin definition and function

Symbol	Function	I/O Type
NC	Not connected	_
OUTA1	Output of leg 1 of H-Bridge A	0
OUTA2	Output of leg 2 of H-Bridge A	0
PGNDAn	Power ground for leg n of H-Bridge A (QFN40 option only; n = 1,2)	PGND
PGNDA	Power ground for H-Bridge A (PSSO36 only)	PGND

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Symbol	Function	I/O Type
PGNDBn	Power ground for leg n of H-Bridge B (QFN40 option only; n = 1,2)	PGND
PGNDB	Power ground for H-Bridge B (PSSO36 option only)	PGND
OUTB2	Output of leg 2 of H-Bridge B	0
OUTB1	Output of leg 1 of H-Bridge B	0
VSBn	Supply voltage for leg n of H-Bridge B (QFN40 option only; n = 1,2)	Supply
VSB	Supply voltage for H-Bridge B (PSSO36 option only)	Supply
VSAn	Supply voltage for leg n of H-Bridge A (QFN40 option only; n = 1,2)	Supply
VSA	Supply voltage for H-Bridge A (PSSO36 option only)	Supply
CTRL3	Configurable control pin 3	I
CTRL2	Configurable control pin 2	I
CTRL1	Configurable control pin 1	I
VREG	Supply voltage for 5 V regulator	Supply
V5V	5 V regulator output	0
VDD	Digital I/Os supply	Supply
V3V	Internal 3V regulator decoupling output	0
GND	GND connection	GND
EN	Enable input	I
DOUT2	Configurable digital output 2	0
DOUT1	Configurable digital output 1	0
CSN	SPI chip select NOT input	
CLK	SPI serial clock input	I
SDI	SPI serial data input	I
SDO	SPI serial data output	0
CPOUT	Charge pump output	0
CP+	Charge pump pin for capacitor, positive side	0
CP-	Charge pump pin for capacitor, negative side	0
AOUT	Analog Output	0

2 Device description

2.1 Supply pins (VS, VREG, VDD)

The device has three different supply input pins:

 VSx pins are used to supply the four H-bridges, VSA pin(s) is (are) also used to supply the charge pump. All of VS pins must be protected against negative voltages.

- VREG pin supplies the embedded 5 V LDO regulator and the 3.3 V regulator supplying internal logic. It must be protected against negative voltages
- VDD supplies all of the digital I/Os, it is intended to be equal to the voltage used to supply the application micro-controller; both 3.3 V and 5 V are supported.

2.2 Voltage regulator (V5V)

The device integrates a low-drop voltage regulator capable of supplying external devices (e.g. external sensors) with a continuous load current up to 50 mA. The output voltage is stable with ceramic output capacitors equal to 220 nF or bigger, placed close to the device. The voltage regulator is protected against short circuit to both GND and battery (for the latter, VREG must be present).

2.3 Charge Pump (CP)

L99SM81V embeds a single stage charge pump which requires a 'flying' external ceramic capacitor placed in between pins CP+ and CP- and an additional ceramic capacitor on pin CP. The charge pump operation is internally monitored and a condition that avoids proper operation of the charge pump will be indicated by the respective SPI diagnosis flag. The charge pump frequency can be modulated with a wobble frequency generator to optimize EMC performance.

2.4 Standby mode (EN)

The EN input has an internal pull-down resistor. The device is in standby mode if EN input is set to logic low level. In this case the voltage regulator, the charge pump and all of the outputs are turned off, registers content is also set to default value.

If EN is set to logic high level then the device enters the active mode after a start-up time equal to tstart. In active mode all functions are available and the device is controlled by the ST SPI interface and the digital control pins.

2.5 Application block diagram

100n CP-External supply V5V 220n Voltage V3V regulator VDD 100n OUTA1 M CSN OUTA2 SCK L99SM81V SDI SDO OUTB1 ΕN μC OUTB2 CTRL1 CTRL2 CTRL3 AOUT DOUT1 PGND DOUT2 Optional connection

Figure 5: Stepper motor driver application block diagram

As it can be seen from the application block diagram, the device may be driven either by Serial Peripheral Intreface (SPI) or by digital inputs/outputs.

2.6 Stepping modes and step update

Depending on desired step resolution - as shown in Figure 6: "Electrical revolution in 1/16th micro step (current profile and phase counter values)" to Figure 10: "Electrical revolution in full step mode (current profiles and phase counter values)" - one stepper motor electrical cycle can consist of 64 micro steps (1/16th micro step mode), 32 micro steps (1/8th micro step mode), 16 mini steps (mini step mode), 8 half steps (half step mode) or 4 full steps (full step mode).

Figure 6: Electrical revolution in 1/16th micro step (current profile and phase counter values)

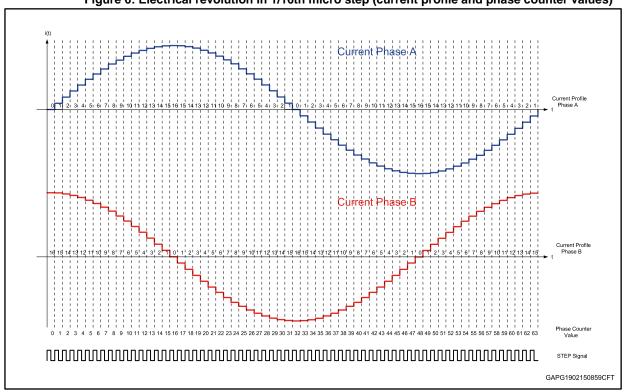


Figure 7: Electrical revolution in 1/8th micro step (current profile and phase counter values)

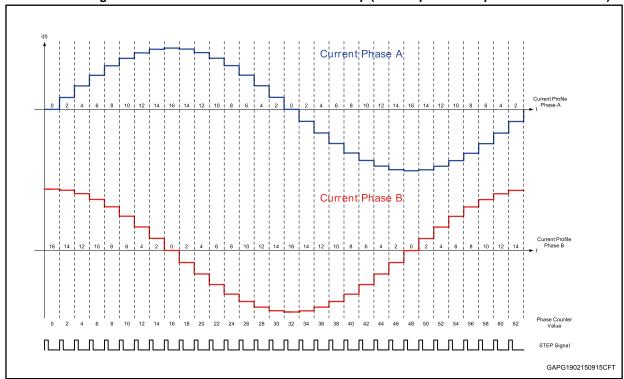


Figure 8: Electrical revolution in mini step (current profiles and phase counter values)

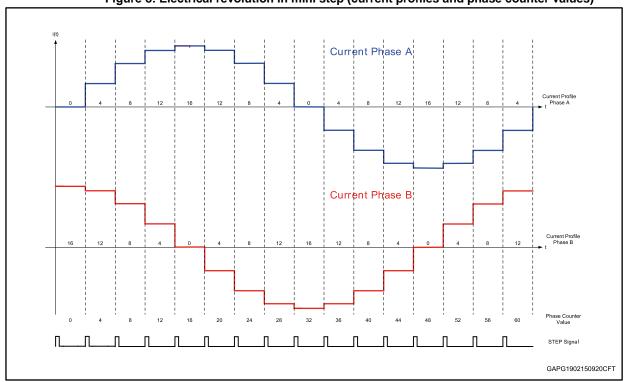
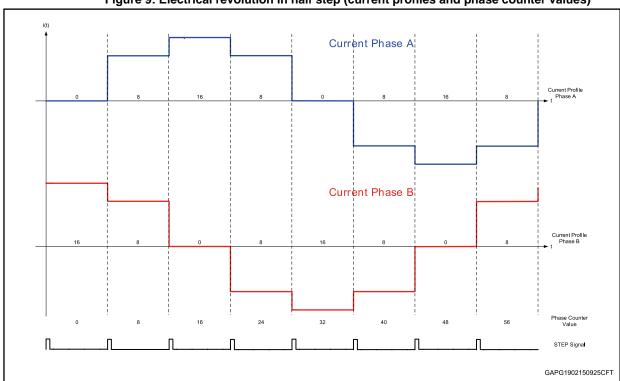


Figure 9: Electrical revolution in half step (current profiles and phase counter values)



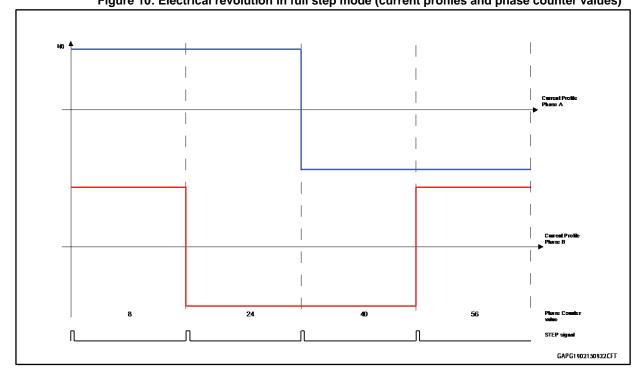


Figure 10: Electrical revolution in full step mode (current profiles and phase counter values)

The current profile generated by the device depends on the phase counter value (stored in PH[5:0] bits in MCR1 register) and it can be altered in an exclusive way either via the SPI interface (MX1 bit = 0) by directly writing PH[5:0] bits or through the CTRL1 pin (MX1 bit = 1) on each rising edge.

Phase counter update becomes effective on next PWM period.

In case MX1 bit is set, user has read-only rights to PH[5:0] bits and the phase counter can only be updated through rising edges on CTRL1 pin. In particular, PH[5:0] is incremented or decremented (depending on running motor direction) by a quantity automatically computed and dependent on the applied Step mode (normally SM[2:0]). Additionally, in case MX3[1:0] (in GCR1 register) is equal to 0x01, the CTRL3 pin can also be used to simultaneously select whether the current Step mode is the one specified by SM[2:0] bits or ASM[2:0] bits (MCR1 register). The automatic increment/decrement of the phase counter amounts to 1 LSB in case of 1/16th microstep mode (SM[2:0] or ASM[2:0] equal to 0x00), 2LSBs in case of 1/8 th microstep mode (SM[2:0] or ASM[2:0] equal to 0x01), 4 LSBs in case of mini-step mode (SM[2:0] or ASM[2:0] equal to 0x02), 8 LSBs in case of half-step mode (SM[2:0] or ASM[2:0] equal to 0x04).

Whenever changing the step mode from a higher resolution to a lower one, the phase counter is adjusted to the next closer phase counter value coherently with the new Step mode. This adjustment is actually applied on the first PWM period after a phase counter change command.

On the contrary, in case MX1 bit is reset, phase counter can only be accessed via SPI and logic level on CTRL1 input is discarded. In order to ensure the maximum flexibility for the application, the computation of the next phase counter value to be written in PH[5:0] is totally left to the application microcontroller. The step mode control bits, which will usually have no impact on the current profile generation when the PHase counter is updated via SPI, will impact the current profile generation only in full step mode.



Any modification of the step mode (either through CTRL3 pin in case MX3[1:0]=0x01 or through SPI writing of bit SM[2:0] and ASM[2:0] in MCR1 register) becomes effective at the beginning of the first PWM cycle following a phase counter update command (either received via CTRL1 pin with MX1=1 or through a SPI writing of PH[5:0] bits with MX1=0).

2.7 Current references generation and PWM regulation

L99SM81V embeds a look-up table composed by 17 entries synthetizing a quarter of a sinusoidal cycle; table elements have 6 bit accuracy. In 1/16th microstep mode each of these table entries represent the value that, once multiplied by the full scale factor stored into CA[3:0] bit of MCREF register, constitute in RUN mode the digital current references for a whole micro step. In HOLD mode, bits HC[3:0] are automatically used instead as full scale factor (see *Figure 11: "Current reference generation block diagram"*).

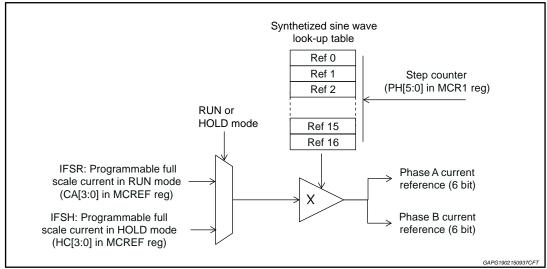


Figure 11: Current reference generation block diagram

Due to the symmetry of the sinusoidal waveform, all the 64 target motor current pairs of an electrical revolution (in 1/16th micro step) can be referenced by both the 17 table entries and the phase counter register. The 6 bit step (phase) counter - in fact - defines both the sign of the current flowing through phases A and B and which of the 17 current entries is to be used for current reference computation

In full step mode - the full scale current defined by either CA[3:0] or HC[3:0] bits in MCREF is entirely applied to the two motor phases (sine-wave look-up table not used), being current direction dependent on step counter value (see *Figure 10: "Electrical revolution in full step mode (current profiles and phase counter values)"*).

In order to achieve the motor current regulation, the current references generated in this way are then compared with the internal motor current mirror (no external shunt resistor).

At the beginning of each PWM period, H-bridges A and B are actively driven (PWM ON phase) until the related current reference is reached.

Once a H-bridge reaches its current reference, it is switched to one of the two possible PWM OFF configurations depending on the selected decay mode (see *Figure 12: "PWM ON and PWM OFF switching states"* for an overview of the switching states).

The PWM frequency for the current regulation is configurable (MCR2 FREQ[1:0]) and can be modulated with a wobble frequency generator by activating this option via SPI (GCR1 MWBE).

In order to avoid spurious misleading triggering of the comparator used for the current regulation loop, a minimum PWM on-time, equal to the sum of the programmable comparator blanking time (t_B) plus the glitch filter delay time (t_{TF}), is always applied.

2.8 HOLD mode

The L99SM81V features a HOLD mode intended to be used when it's required to hold the motor in a given position; HOLD mode is entered either by setting via SPI the HOLDM bit in register MCR1 (if MX3[1:0] \neq 10b) or by setting a logic high value on pin CTRL3 (if MX3[1:0] = 10b).

In case bit AHMSD in MCR3 register is set, then HOLDM bit is set automatically (regardless of MX3 bits value and CTRL3 input level) after a stall condition is detected for a number of consecutive times equal to SD[2:0] (in this case it's necessary either to clear the SDF bit in the Status Register or to reset the AHMSD in the MCR3 Register before HOLDM bit can be cleared).

When In HOLD mode:

- The motor current reference is computed automatically for both motor phases starting from the full scale factor stored in bits HC[3:0] of MCREF register.
- The applied decay mode is set accordingly to DMH bit in MCR2
- The PH[5:0] bits can be still updated unless the HOLDM bit is set because of the AHMSD control bit set to one on a stall event detection pointed out by the SDF flag; only in this latter case the phase counter will be frozen as long as both bits (SDF and AHMSD) are set.

2.9 Decay modes

This device features different types of current decay modes. They are implemented to allow a flexible adaptation of the current regulation loop properties to the application requirements. The decay mode can be selected via SPI register MCR2 (DMR[1:0] bits for RUN mode, DMH bit for HOLD mode).

Figure 12: "PWM ON and PWM OFF switching states" shows an overview of the basic switching states during the PWM ON phase and the PWM OFF phase. Each decay mode is a combination of these basic switching states with different trigger events.

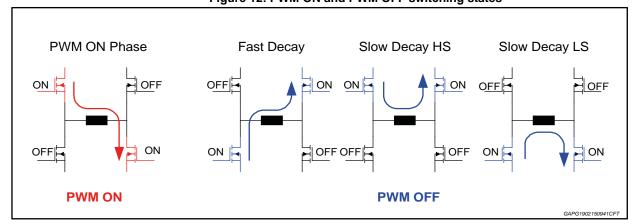


Figure 12: PWM ON and PWM OFF switching states

For the slow decay state it is configurable which freewheeling current path will be used (either high-side or low-side) see SPI Register MCR2 SDAFW&SDBFW.

In Fast Decay state the opposite switches in each half - bridge are active – like when driving the current in the opposite direction in PWM ON phase. This allows decreasing the motor phase current faster if compared to Slow Decay but results in a higher current ripple.

In order to combine the advantages of a low current ripple with those of a fast and responsive current regulation, L99SM81V features a dedicated configuration (auto decay mode 2) in which the decay mode is dynamically and automatically adjusted by the device as described in Section 2.9.4: "DMR[1:0] bits = 11b - Auto decay mode 2".

2.9.1 DMR[1:0] bits = 01b, DMH = 0 - Slow decay mode always applied

If DMR[1:0] bits are equal to 01b, Slow Decay Mode is always applied in RUN mode after the PWM ON phase. Likewise, slow decay mode is also always applied in HOLD mode if DMH = 0.

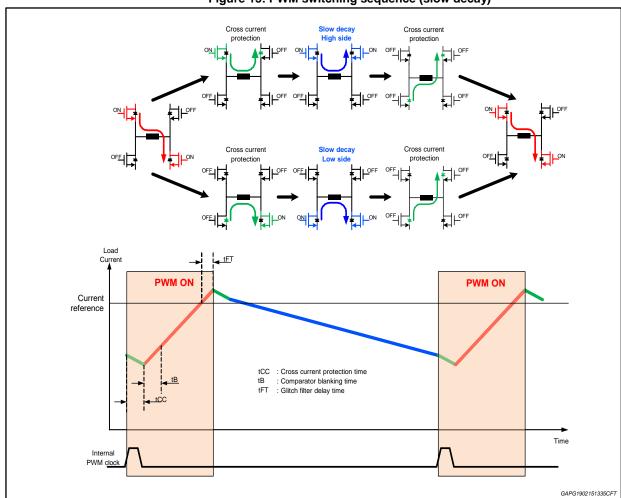


Figure 13: PWM switching sequence (slow decay)

2.9.2 DMR[1:0] bits = 10b, DMH = 1 - Mixed decay mode always applied

If DMR[1:0] bits are equal to 10b, Mixed Decay Mode is always applied in RUN mode. Likewise, mixed decay mode is also always applied in HOLD mode if DMH = 1. In Mixed Decay Mode the PWM ON phase is followed by a fast decay state, which is followed in turn by a slow decay. The start of the slow decay is triggered as soon as the actual current crosses the reference current and the filter time t_{FT} has elapsed.

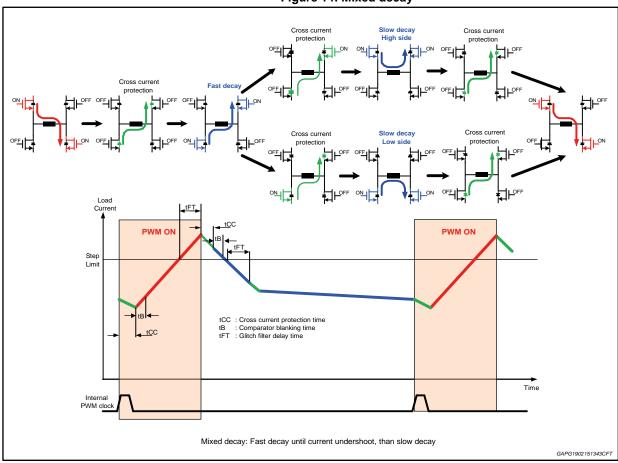


Figure 14: Mixed decay

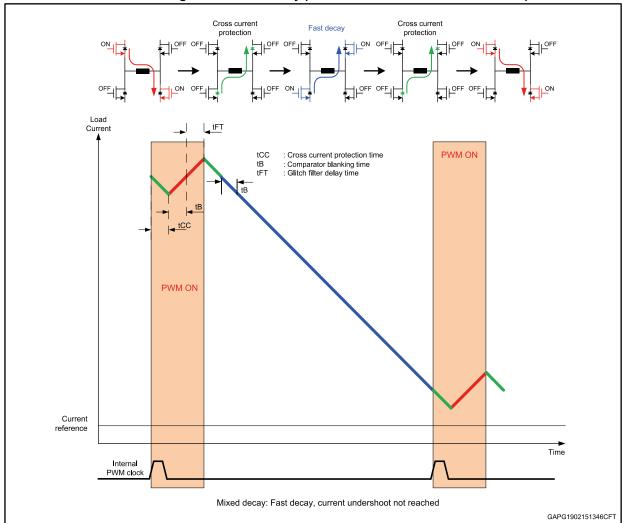


Figure 15: Mixed decay (current undershoot / limit not reached)

2.9.3 DMR[1:0] bits = 00b - Auto decay mode 1

In Auto Decay Mode1 the phase counter value and the motor spinning direction (DIR bit) are taken into account to select the appropriate switching state specifically, either a slow decay or a mixed decay are applied.

The next two figures show the dependency of the applied decay mode from the phase counter and the direction bit. See also paragraph Section 2.9.2: "DMR[1:0] bits = 10b, DMH = 1 - Mixed decay mode always applied" for mixed decay mode description.

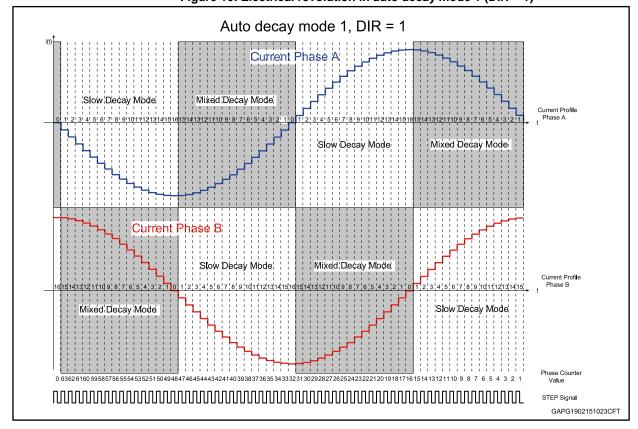
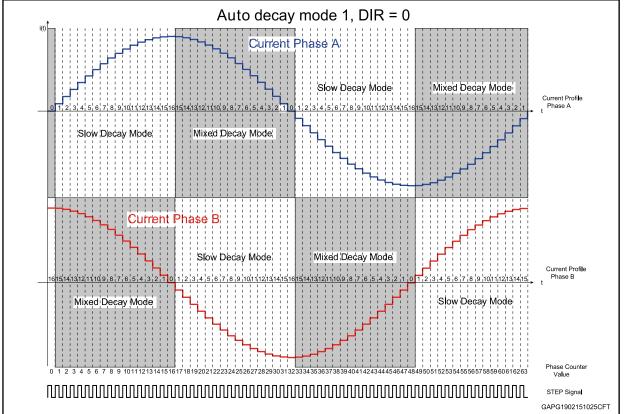


Figure 16: Electrical revolution in auto decay mode 1 (DIR = 1)

Figure 17: Electrical revolution in auto decay mode 1 (DIR = 0)



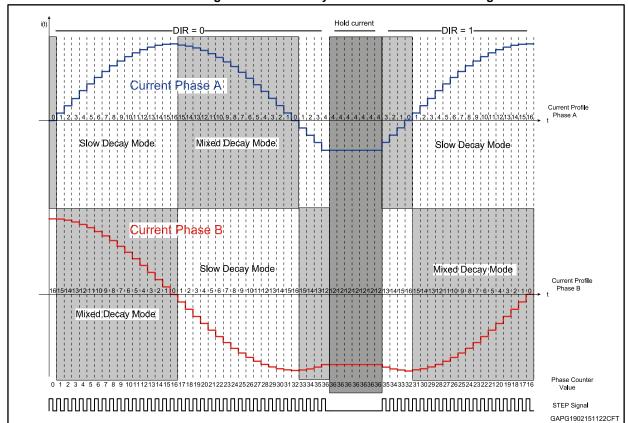


Figure 18: Auto decay mode 1 with direction change

2.9.4 DMR[1:0] bits = 11b - Auto decay mode 2

Auto decay mode 2 allows combining at the best the advantages of a low current ripple together with those of a fast and responsive current regulation. In Auto Decay Mode2, the phase counter value, the motor spinning direction (DIR bit) and the status of the real current vs. the current reference are taken into account to select the appropriate switching state. Figure 19: "Auto decay mode 2, DIR = 0" shows the dependence of the decay mode from the phase counter in case DIR=0 (applied decay mode are opposite in case of DIR =1)

In particular, with reference to the areas where a combination of slow and mixed decay modes is applied, mixed decay is used - in order to achieve the fastest current responsiveness - as soon as a new step begins and till the moment the motor phase current crosses the new (lower in absolute value) current reference, slow decay is then applied in order to reduce the switching losses and the current ripple vs. the mixed decay mode. See also paragraph Section 2.9.2: "DMR[1:0] bits = 10b, DMH = 1 - Mixed decay mode always applied" for mixed decay mode description.

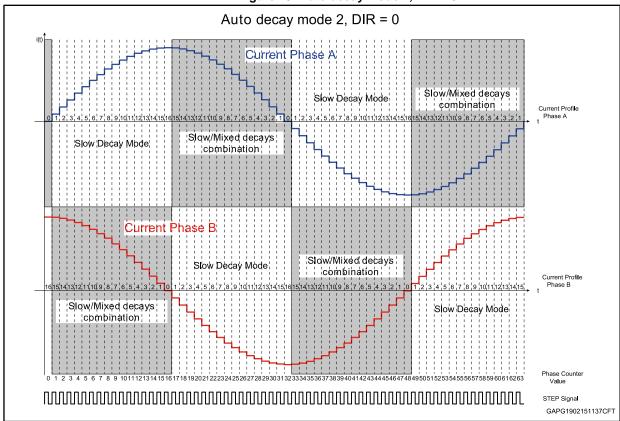
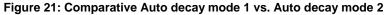
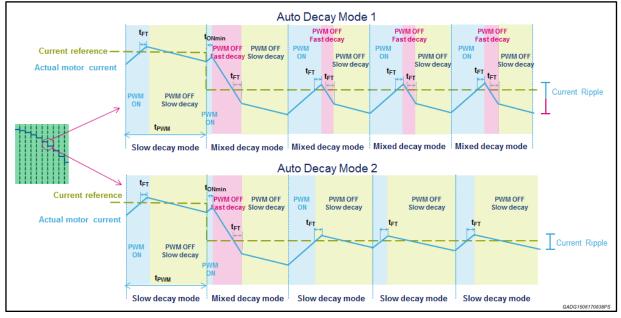


Figure 19: Auto decay mode 2, DIR = 0

New current reference crossed within t t_{FT} t_{ON min} **Current reference** PWM OFF **PWM OFF** PWM ON PWM OFF Fast decay Slow decay Slow decay **Actual motor current** PWM OFF ON Slow decay Slow decay mode | Mixed decay mode | Slow decay mode New current reference crossed within 2 x t t_{FT} t_{ON min} **Current reference PWM OFF** PWM OFF PWM **PWM OFF** Slow decay Fast decay Slow decay **Actual motor current** PWM OFF Fast decay **PWM OFF PWM** \mathbf{t}_{FT} t_{FT} Slow decay ON Slow decay mode | Mixed decay mode | Mixed decay mode | Slow decay mode

Figure 20: Auto decay mode 2, behavior at micro-step change (dead-time omitted)

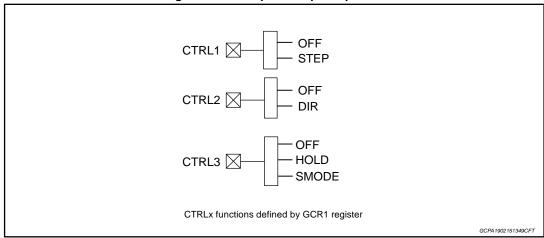




2.10 Control pins (CTRLx)

Some of the functions in the L99SM81V can be controlled directly by application microcontroller I/Os (without using SPI communications) through the CTRLx digital input pins. The action to be executed by these pins is defined by MX bits in GCR1 registers.

Figure 22: CTRL pin multiplex options



2.10.1 Step Control (STEP)

If MX1 bit in GCR1 register is reset, no function is associated to the CTRL1 pin. Any step change can only be achieved by writing to the SPI PH[5:0] bits via SPI. If MX1 bit is set, a rising edge on this digital input causes the phase counter to be immediately updated (according to DIR bit) whereas the reference current is updated with the new value at the beginning of next PWM cycle (PH[5:0] can only be read through SPI in this case). If the DIR bit in the motor control register is reset then the phase counter will be incremented; if the DIR bit is set, then the phase counter will be decremented.

The decrement or increment value depends on the currently applied Step mode.

2.10.2 Direction Control (DIR)

If MX1 bit is reset in GCR1 register, the update of the phase counter (via SPI) is totally left to the application microcontroller. As a consequence, whatever is the value of MX2 bit, the direction is thus as well managed by the external microcontroller.

If MX1 is set, CTRL1 input holds the STEP functionality; the motor spinning direction is set in this case either via SPI or through direct input (CTRL2) depending on the value of MX2 bit.

If MX2 bit in GCR1 register is reset, no function is associated to the CTRL2 pin; DIR bit in MCR1 can only be written through SPI in this case.

If MX2 bit is set, the DIR bit can only be altered by CTRL2 pin: a high (low) logic level on this digital input will cause the direction bit DIR to be synchronously set (reset).

2.10.3 Step mode Control (SMODE) and HOLD mode

If MX3[1:0] bits in GCR1 register are equal to 0x00 or 0x03, no function is associated to the CTRL3 pin. The Step mode utilized in this case is either defined by SM[2:0] bits (MX1 bit = 1) or left to application microcontroller (MX1 bit = 0, full step mode apart). HOLD mode is entered by setting HOLDM bit in MCR1 through SPI.

If MX3[1:0] bits in GCR1 register are equal to 0x01, CTRL3 input selects the Step mode to be used: if CTRL3 = 0, the active step mode is the one defined by SM[2:0], otherwise the

active step mode is the one defined by ASM[2:0]. To be noticed that if MX1 is reset, Step mode is intrinsically managed by the application microcontroller as it defines by itself the amount of increment or decrement to be applied on the phase counter. HOLD mode is entered by setting HOLDM bit in MCR1 through SPI.

If MX3[1:0] bits in GCR1 register are equal to 0x02, CTRL3 pin is used as HOLD input, HOLDM bit reflects the logic state on CTRL3 and can't be altered through SPI. In case AHMSD is set, HOLDM bit is set in case of stall detection (SDF flag set) independently from CTRL3 pin logic level.

2.11 Digital outputs

The device features several diagnostic functions that can be reported to the microcontroller without starting an SPI communication. These signals can be assigned to device outputs by programming SPI configuration bits [11:7] in register GCR2.

If bits DOUT1[1:0] or DOUT2[1:0] in GCR2 register are set to 00b, the device will not drive the corresponding DOUTn pin.

DOUT1 OFF

CVRDY

CVLL

CVRUN

OFF

PWM

ERR

EC

Figure 23: Configurable I/O multiplex options

2.11.1 Error/ warning indicator (ERR)

This signal is a logical OR combination of all diagnostic and warning flags contained in Global Status Register (GSR).

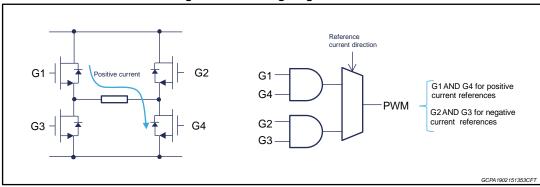
2.11.2 Error/ warning change indicator (EC)

This signal is set every time any of the diagnostic and warning flags contained in GSR is set. Any read access to the GSR register will reset this signal to low level.

2.11.3 PWM

As shown in *Figure 24: "PWM signal generation"* this signal reflects the PWM control signal applied to the H-bridge A outputs.

Figure 24: PWM signal generation



2.11.4 Coil Voltage Conversion Ready (CVRDY)

A rising edge on this signal indicates that averaged coil voltage measurement is available in the respective MCV register.

A falling edge on this signal occurs when a new zero-current micro-step begins.

2.11.5 Coil Voltage Runaway (CVRUN)

CVRUN signal is updated every time a new coil voltage measurement is available. If the latest stored coil voltage value is higher than CVUL threshold or lower than CVLLA threshold, the signal is set, otherwise is reset.

2.11.6 Coil Voltage Lower Limit Underrun (CVLL)

CVLL signal is updated every time a new coil voltage measurement is available (rising edge of signal CVRDY). If the latest stored coil voltage value is lower than CVLLB, the signal is set, otherwise it is reset.

2.12 Analog output

The device features an analog output which - depending on AOUT[1:0] bits in GCR1 register - can be used either to feed back the device embedded thermal sensor output (AOUT[1:0]=01b) or a precise band-gap voltage reference (AOUT[1:0]=10b).

2.13 Motor coil voltage measurement for stall detection

Setting CVE bit in MCR3 enables the automatic measurement of the voltage across the motor terminals during each zero-current step; this makes it possible to measure the voltage induced by the rotor movement (BEMF) and thus have information about motor speed.



In order for the motor coil voltage measurement to be correctly performed, it's required that bit MWBE in GCR1 is reset.

Four BEMF values are converted within a complete electrical cycle (*Figure 25: "Coil voltage registers content (DIR = 0, positive current flowing from OUTx1 to OUTx2; x = A, B)"*), related digital values are stored into registers MCVA, MCVB, MCVC, MCVD and bits CVLUR[1:0] in MCR3 indicate which of MCVx registers was lastly updated.

The motor terminal to be sampled is automatically selected depending on the rotation direction and on phase counter value so that only positive BEMF is always measured (see also *Table 2: "Coil voltage synopsis table"*).

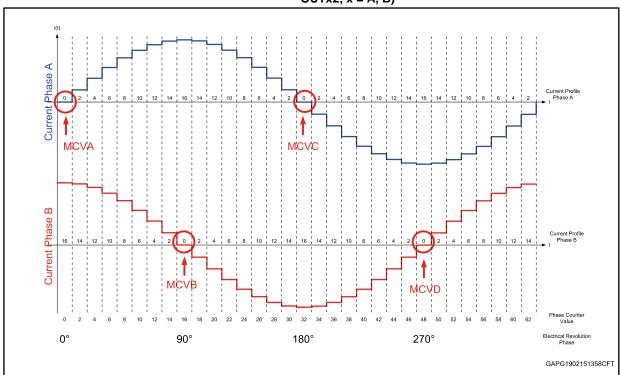


Figure 25: Coil voltage registers content (DIR = 0, positive current flowing from OUTx1 to OUTx2; x = A, B)

In order for the sampled coil voltage to be really equal to the BEMF induced by the rotor, the PWM signals applied to the H-bridge driving the coil under examination are switched off as soon as the zero-current step begins. In addition - after a dead-time and according to Table 2: "Coil voltage synopsis table" - the low side power switch opposite to the output to be converted is switched on (see Figure 26: "Coil voltage measurement sequence example") in order to have coil voltage measurement referred to GND.

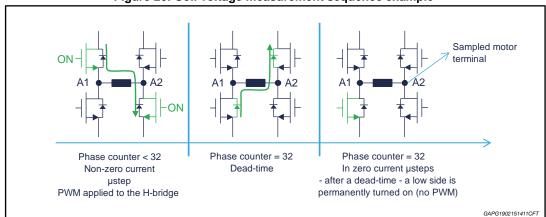


Figure 26: Coil voltage measurement sequence example

Table 2: Coil voltage synopsis table

	DIR bit = 0 (phase counter increasing)				
Phase counter	Output to GND	Motor terminal sampled	Output to GND	Motor terminal sampled	Updated register
0	A2	A1	A1	A2	MCVA
16	B1	B2	B2	B1	MCVB
32	A1	A2	A2	A1	MCVC
48	B2	B1	B1	B2	MCVD

2.13.1 Coil voltage measurement triggering

In order to filter out any PWM commutation noise, several A/D conversions are carried out and averaged over each PWM period (the number of averaged samples ranges from 8 to 16, depending on programmed PWM frequency). The digital averaged value is then transferred into proper MCVx register on a triggering event which depends on bits D[4:0] in register MCR3:

- D[4:0] = 00000b; trigger at the end of the zero-current step.
 Digital averaged coil voltage is transferred into MCVx register at the end of a zero current step (that is as soon as a step counter change becomes effective, default option).
- 2. D[4:0] > 00001b; trigger delayed from the start of the zero-current step. During a zero-current step, the digital averaged coil voltage is transferred into MCVx register after a given number of PWM cycles defined by bits D[4:0] in register MCR3 have elapsed. In case the step counter update command is given before the programmed PWM cycles have elapsed, the zero-current step duration is extended till that time, thus delaying the actual phase counter update.

2.13.2 Coil voltage measurement processing

As soon as the triggering event occurs, both proper MCVx register and bits CVLUR[1:0] in MCR3 (indicating which of MCVx registers lastly changed) are updated. Also, CVRDY signal goes from low to high (falling edge of CVRDY signal indicates that zero-current step has started).

As soon as a new value is stored into MCVx register, the same value is automatically compared with user-configurable thresholds:

47/

- CVUL, stored in MCVUL register
- CVLLA, stored in MCVLLA register
- CVLLB, stored in MCVLLB register

Depending on the comparison result, flags CVULF, CVLLAF and CVLLBF are also updated in MSR:

- CVULF is set if sampled coil voltage exceeds CVUL threshold, it is reset otherwise
- CVLLAF is set if sampled coil voltage falls below CVLLA threshold, it is reset otherwise
- CVLLBF is set if sampled coil voltage falls below CVLLB threshold, it is reset otherwise

Additionally

- CVRUN signal is set if latest stored coil voltage value is higher than CVUL or lower than CVLLA, it is reset otherwise
- CVLL signal is set if the latest sampled coil voltage value is lower than CVLLB, it is reset otherwise

If the sampled coil voltage value is out of the range [CVLLA; CVUL] for a number of consecutive acquisitions (zero-current steps) equal to SD[2:0], then the bit SDF of the GSR is set. If the bit AHMSD in MCR3 register is set, then the HOLDM bit (in MCR1) is also automatically set and the driver enters HOLD mode. See also Section 2.8: "HOLD mode" for more information about HOLD mode.

The SDF status flag is also reported in the Global Status Byte as FE.

2.14 Serial peripheral interface (ST SPI standard)

This device features a 24-bit ST SPI in slave configuration for bi-directional communication with an external microcontroller. This device supports burst read access and shall be operated in the following mode: CPOL = 0 and CPHA = 0.

For this mode, input data is sampled on the rising edge of the clock signal SCK and output data is changed on the falling edge of SCK.

During standby mode, the SPI interface is deactivated.

Signal Description:

- Chip Select Not (CSN)
 - The input pin is used to select the serial interface of this device. When CSN is high, the output pin (SDO) will be in high-impedance state. In case CSN is stuck at GND, a timeout is implemented which sets the SDO line back to high-impedance to release the SPI network. A low signal activates the output driver and a serial communication can be started. The state during CSN = 0 is called a communication frame.
- Serial Data In (SDI)
 - The input pin is used to transfer data serially into the device. The data applied to SDI will be sampled on the rising edge of the SCK signal and shifted into an internal 24-bit shift register. On the rising edge of the CSN signal, the contents of the shift register will be transferred to the Data Input Register. Only communication frames with 0 (read GSBN bit), 24 (standard communication frame), or 24 + (n * 16) (burst read/write) clock pulses are accepted. All others will be ignored and a communication error will be reported with the next SPI command.
- Serial Data Out (SDO)
 - The data output driver is activated by a logic low level at the CSN input. After a falling edge of the CSN pin, the SDO pin will leave the tri-state condition and present the GSBN bit. At all following falling edges of the SCK signal, the following bits of the SPI frame are shifted out to the SDO pin.



Serial Clock (SCK)

The SCK input is used to synchronize the input and output serial bit streams. The data input (SDI) is sampled on the rising edge of the SCK and the data output (SDO) will change with the falling edge of the SCK signal. The SPI can be driven with a SCK frequency up to 4 MHz.

3 Protections and diagnostics

3.1 Supply diagnostics

3.1.1 VS overvoltage and undervoltage

If the voltage on the supply pins VS rises above the overvoltage threshold, VSOV flag in GSR register is set and latched, the charge pump is switched off and ME bit (MCR1 register) is cleared, thus putting the device outputs in high impedance. VS has to drop below the overvoltage threshold minus the over-voltage hysteresis to allow the clearing of VSOV bit.

Likewise, if the voltage on the supply pins VS falls below its undervoltage threshold, the corresponding undervoltage diagnosis flag (VSUV bit in GSR register) is set, ME bit is cleared and charge pump is switched off. VSUV bit can be cleared (and consequently, ME bit can be set) by the microcontroller when VS voltage has risen above the undervoltage threshold plus the undervoltage hysteresis.

3.1.2 VREG overvoltage and undervoltage

If the voltage on the supply pin VREG rises above its overvoltage threshold, the corresponding overvoltage diagnosis flag (VREGOV bit in GSR register) is set and the V5V regulator is switched off. VREGOV bit can be cleared by the microcontroller when VREG voltage has dropped below the overvoltage threshold minus the overvoltage hysteresis.

If the voltage on the supply pin VREG falls below its undervoltage threshold warning, the corresponding undervoltage diagnosis flag (VREGUV bit in GSR register) is set. VREGUV flag can be cleared by the microcontroller when VREG voltage has risen above the undervoltage threshold plus the undervoltage hysteresis. If VREG voltage decreases further below the VREG POR threshold, the device is reset and the registers are reset to their default value.

3.1.3 CP failure

The charge pump operation is internally monitored. If the charge pump voltage falls below the VCPLOW threshold, the CP failure flag CPFAIL in GSR is set and the charge pump is switched off. This clear also the ME bit, thus disabling the output drivers. The CP failure flag can be cleared through a dedicated Read & Clear SPI command. Once the flag is cleared, the ME bit can be set.

3.1.4 V5V undervoltage warning

If the output voltage on pin V5V drops below the undervoltage warning threshold V5UVW, the V5V undervoltage warning flag V5UVW in GSR is set.

This flag can be cleared by a Read & Clear SPI command.

3.1.5 V5V failure

If the output voltage on pin V5V rises above the V5V overvoltage threshold (V5VOV), then the V5V failure flag is set and the voltage regulator is disabled.

In case the 5V regulator output drops below the V5VFAIL threshold, the L99SM81V detects a short circuit to ground, the V5V failure flag (V5VUV) is latched and the voltage regulator is disabled. If the output of the regulator doesn't exceed the V5VFAIL threshold after a time equal to t_{FTO}, the device detects a short-circuit condition, the regulator is switched off and



the corresponding failure flag is set. To re-enable the voltage regulator, the failure flag has to be cleared.

3.1.6 VDD failure

In case VDD voltage falls below the threshold VDDPORF, the internal registers are reset to their default values. The power-on reset is released once VDD rises above VDDPORR.

3.2 Thermal warning and thermal shutdown

If the junction temperature reaches the TW threshold, the TW flag in GSR is set and latched. In case the junction temperature increases and reaches the TSD threshold, the two full-bridges, the charge pump and the voltage regulator V5V are disabled to protect the device and the TSD flag in GSR is set and latched. In order to re-enable the driver, the junction temperature must decrease below the thermal shutdown threshold, the thermal shutdown error flag must be cleared by the microcontroller and the ME bit must be set again.

3.3 Cross current protection (dead-time)

The device features an internal dead-time generator for cross current protection. The duration of the dead-time is automatically adjusted according to the SR[1:0] bits in MCR2 register which set the turn-on and turn-off speed of the integrated power MOSFETs.

3.4 Driver diagnostic

3.4.1 Overcurrent detection

If the current through any of the switches in the output driver exceeds the output overcurrent limit IOCxn for longer than tOC, then the corresponding overcurrent error flag in the motor status register MSR is set and the outputs are set in high impedance state (ME bit reset in MCR1).

To re-enable the output drivers, the error flag OC has to be cleared in GSR by the application microcontroller and the ME bit must be set again.

3.4.2 Open load detection

Starting from the beginning of any PWM cycle, if the motor current doesn't reach the current reference for a period of time longer then a programmable delay (OLDLY bit in MCR2), then the corresponding open load flag (OLA or OLB bits, depending on which of the motor phase is failing) is set in MSR register.

These flags don't affect the output drivers and can be cleared by clearing the OL flag in GSR.

4 Electrical characteristics

4.1 Absolute maximum ratings

Table 3: Absolute maximum ratings

Symbol	Parameter	Value	Unit
VS	Power supply voltage	-0.3 to 40	V
VREG	Voltage regulator power supply	-0.3 to 40	V
VDD	Digital I/Os supply	-0.3 to 6	V
V5V	Voltage regulator output	-0.3 to 40	V
VCP, CP+	Charge pump output voltage, positive connection for charge pump capacitor	VSA - 0.3 to 45 V (in case VSA >28V) or VSA +17 V (in case VSA<28)	V
CP-	Charge pump pin for negative capacitor connection	-0.3 to VSA+0.3 V	V
VOUTxn	Output voltage (x = A,B; n = 1,2)	-0.3 to VS + 0.3	V
VEN, VCTRLn, VDOUTn, VSDO, VSDI, VCLK, VCSN	Logic I/O voltage range (x = 1,2; n = 1,2,3)	-0.3 to 6	٧
AOUT	Analog output	-0.3 to 40	V

All maximum ratings are absolute ratings. Exceeding any of these values may cause an irreversible damage of the integrated circuit!

4.2 Operating range

Table 4: Operating range

Symbol	Parameter	Value	Unit
VS	Power supply voltage	6 to 28	V
VREG	Voltage regulator power supply	6 to 28	V
VDD	Digital I/Os supply	3 to 5.5	V
VEN, VCTRLn, VDOUTn, VSDO, VSDI, VCLK, VCSN	Logic I/O voltage range ($x = 1,2$; $n = 1,2,3$)	0 to VDD	٧

4.3 ESD protection

Table 5: ESD protection

Parameter		
Electrostatic Discharge Test (AECQ100-002-E) all pins	±2	kV
Electrostatic Discharge Test (AECQ100-002-E) output pins VOUTKXN (X = A,B; N, $K = 1,2$)	±4	kV
Charge device model (CDM-AEC-Q100-011) all pins	±500	V
Charge device model (CDM-AEC-Q100-011) corner pins	±750	V

Electrical characteristics L99SM81V

4.4 Thermal data

Table 6: Thermal data

Symbol	Parameter	Test condition	Min.	Тур.	Max.	Unit
T _{stg}	Storage temperature		-55		150	ô
Tj	Operating junction temperature		-40		150	°C
T _{j-peak}	Peak junction temperature (1)			160		°C
Rth j-amb	Junction-to-ambient thermal resistance (2)	PowerSSO-36 package		17		°C/W
		QFN40L package		23		
Rth j-case	Junction-to-case thermal resistance	PowerSSO-36 package		5		°C/W
		QFN40L package		6.5		°C/W

Notes:

Table 7: Thermal warning and thermal shutdown

Symbol	Parameter	Test condition	Min.	Тур.	Max.	Unit
TW	Thermal warning threshold (1)		140	150	160	°C
TSD	Thermal shutdown threshold		160	170	180	°C
TSDH	Thermal shutdown hysteresis			5		°C
t _{TFT}	Thermal filter time	Tested by scan chain		64		μs

Notes:

4.5 Main electrical characteristics

Voltages are referred to ground and currents are assumed positive when the current flows into the pin.

The device is operated in the specified operating range, unless otherwise specified.

Table 8: Supply and supply monitoring

Symbol	Parameter	Test condition	Min.	Тур.	Max.	Unit
VSOV	Overvoltage threshold on VS supply		28.1	30	32	V
VSOVH	Overvoltage hysteresis on VS supply		0.5			٧
VSUV	Undervoltage threshold on VS supply		5.2	5.5	5.9	٧

 $^{^{(1)}}$ No more than 100 cumulative hours over lifetime.

⁽²⁾ Device soldered on 2s2p PCB thermally enhanced (slug included).

⁽¹⁾Thermal warning and shutdown thresholds not overlapping.

Symbol	Parameter	Test condition	Min.	Тур.	Max.	Unit
VSUVH	Undervoltage hysteresis on VS supply		0.3			V
VREGOV	Overvoltage threshold on VREG supply		28.1	30	32	V
VREGOVH	Overvoltage hysteresis on VREG supply		0.5			V
VREGUV	Undervoltage warning threshold on VREG supply		5.2	5.5	5.9	V
VREGUVH	Undervoltage warning hysteresis on VREG supply		0.3			V
t∨FT	Overvoltage and undervoltage filter time	Tested by scan chain		64		μs
Is	VS supply current in active mode	VS = 13.5 V; EN = VDD = 5 V; open outputs; SR = 70 V/μs; FREQ[1:0] = 01b (30 kHz PWM)		4	6	mA
lob	VDD supply current in active mode	VS = 13.5 V; EN = CSN = VDD = 5 V; SCK = SDI = STEP = 0 V; open outputs		1.2	1.8	mA
IREG	VREG supply current in active mode	VS = VREG = 13.5 V; EN = VDD = 5 V; open outputs; SR = 70 V/µs; FREQ[1:0] = 01b (30 kHz PWM)		7.5	12.3	mA
Isa	VS quiescent supply current in	VS = 13.5 V; VDD = 5 V; EN = 0V; open outputs; T _{TEST} = -40 °C to 25 °C;		3	10	μΑ
	standby mode	VS = 13.5 V; VDD = 5 V EN = 0V; open outputs; T _{TEST} = 125 °C;		6	20	μΑ
I _{DDQ}	VDD quiescent supply current in	VS = 13.5 V; VDD = 5 V EN = 0V; open outputs; T _{TEST} = -40 °C to 25 °C;		3	10	μΑ
	standby mode	$VS = 13.5 \text{ V}$; $VDD = 5 \text{ V}$ $EN = 0V$; open outputs; $T_{TEST} = 125 \text{ °C}$;		6	20	μΑ
IREGQ	VREG quiescent supply current in standby mode	VS = VREG = 13.5 V; VDD = 5 V; EN = 0 V; open outputs			5	μΑ

Table 9: Power on reset

Symbol	Parameter	Test condition	Min.	Тур.	Max.	Unit	
VDDPORR	Power-on-reset rising	VDD rising	2.2		2.8	V	
VDDPORF	Power-on-reset falling	VDD falling	2	2.3	2.5	V	
VDDPORH	Power-on-reset hysteresis	VDD POR hysteresis	0.2			V	
VREGPORR	Power-on-reset rising	VREG rising	3.1	3.5	3.9	V	
VREGPORF	Power-on-reset falling	VREG falling	2.9	3.3	3.8	V	
VREGPORH	Power-on-reset hysteresis	VREG POR hysteresis	25			mV	

Table 10: Voltage regulator V5V

Symbol	Parameter	Test condition	Min.	Тур.	Max.	Unit
V5V	Output voltage			5.0		V
	Output voltage tolerance including line and load regulation	Active mode; 0 mA < I _{V5V} <= 40 mA; 8 V <= VREG < 28 V	-5		5	%
V5V		Active mode; 0 mA < I _{V5V} <= 25 mA; 6 V <= VREG < 8 V	-5		5	%
loau regulation	Active mode; 25 mA < I _{V5V} <= 40 mA; 6 V <= VREG < 8 V	-5		5	%	
I _{V5VP}	Output peak current	Max. continuous load current			50	mA
I _{V5} VLIM	Short-circuit output current	Current limitation	50		150	mA
CV5V	Load capacitor	Ceramic (+/- 20%)		0.22		μF
V5UVW	Undervoltage warning threshold		4	4.2	4.4	>
V5VOV	Overvoltage threshold		5.42	5.9	6.38	>
V5VFAIL	Fail threshold		1.8	2	2.2	V
tuvft	Undervoltage warning filter time	Tested by scan chain		16		μs
tovft	Overvoltage filter time	Tested by scan chain		16		μs
t _{FFT}	Fail filter time	Tested by scan chain		16		μs
tғто	Fail time-out filter (start-up condition)	Tested by scan chain		4		ms

L99SM81V Electrical characteristics

Table 11: AOUT electrical characteristics

Symbol	Parameter	Test condition	Min.	Тур.	Max.	Unit
VBG	Output voltage bandgap	T _j = 25 °C		1.206		V
	Whole range accuracy	-40 °C < T _i < 150 °C; 6 V < VREG < 28 V	-2.5		2.5	%
T _{SENSE}	Thermal sensor output	T _j = 25 °C		1.32		V
52.752	Thermal coefficient			-4.24		mV/K

Table 12: OUTxn outputs (x = A,B; n = 1,2)

Symbol	Parameter	Test condition	Min.	Тур.	Max.	Unit
5 110		VS = 13.5 V; T _J = 25°C; Ixn = -1.25 A		0.7	-	Ω
Rxn_HS	ON-resistance OUTxn to VS	VS = 13.5 V; T _J = 150 °C; Ixn = -1.25 A		1.14	1.3	Ω
Dvo I C	ON registence OUTvn to BCND	VS = 13.5 V; T _J = 25 °C; Ixn = 1.25 A		0.7	-	Ω
Rxn_LS	ON-resistance OUTxn to PGND	VS = 13.5 V; T _J = 150 °C; Ixn = 1.25 A		1.14	1.3	Ω
IOCxn	Output overcurrent protection threshold	Static test	1.9	2.2	2.75	Α
		CA[3:0] = 0x0F	1204	1353	1502	mA
		CA[3:0] = 0x0E		1160		
		CA[3:0] = 0x0D		1051		
		CA[3:0] = 0x0C		920		
		CA[3:0] = 0x0B		812		
		CA[3:0] = 0x0A		679		
		CA[3:0] = 0x09		571		
 IFSR	Full scale current threshold in	CA[3:0] = 0x08		465		
JII OK	RUN mode	CA[3:0] = 0x07		396		
		CA[3:0] = 0x06		375		
		CA[3:0] = 0x05		329		
		CA[3:0] = 0x04		323		
		CA[3:0] = 0x03		302		
		CA[3:0] = 0x02		220		
		CA[3:0] = 0x01		198		
		CA[3:0] = 0x00	141	176	211	mA
IFSH	Full scale output current in	HC[3:0] = 0x0F	290	326	362	mA
	HOLD mode	HC[3:0] = 0x0E		292		

Symbol	Parameter	Test condition	Min.	Тур.	Max.	Unit
		HC[3:0] = 0x0D		264		
		HC[3:0] = 0x0C		230		
		HC[3:0] = 0x0B		202		
		HC[3:0] = 0x0A		168		
		HC[3:0] = 0x09		140		
		HC[3:0] = 0x08		118		
		HC[3:0] = 0x07		101		
		HC[3:0] = 0x06		95		
		HC[3:0] = 0x05		84		
		HC[3:0] = 0x04		79		
		HC[3:0] = 0x03		73		
		HC[3:0] = 0x02		62		
		HC[3:0] = 0x01		50		
		HC[3:0] = 0x00	7	28	49	mA
IRELERR	Relative error on current reference between Motor X Phase A and Phase B	CA[3:0] = 0x0F	-7.5		7.5	%
tcc	Cross current protection time (dead-time)	See Table 14: "PWM control"				

Table 13: Charge pump

Symbol	Parameter	Test condition	Min.	Тур.	Max.	Unit
		VS = 6 V, I _{CP} = -6 mA	VS + 4.6	VS + 4.9		V
VcP	Charge pump output voltage	VS ≥ 10 V, I _{CP} = -6 mA	VS+8	VS + 8.5		V
	output voltage	VS ≥ 13.5 V; I _{CP} = -6 mA	VS+10			V
ICPLIM	Charge pump output current limitation	VCP = VS; VS = 13.5 V; C1 = CCP = 100 nF			70	mA
V _{CPLOW}	Charge pump low threshold voltage		VS + 3.7	VS + 4.2	VS + 4.5	٧
	Charge numn	CPWBE=0		500		kHz
f _{CP} Charge pump frequency		CPWBE=1		500 ±62.5		kHz
CFLY	Fly capacitor		50	100	150	nF

Table 14: PWM control

Table 14: PWM control									
Symbol	Parameter	Test condition	Min.	Тур.	Max.	Unit			
		FREQ[1:0] = 00b; MWBE=0		20		kHz			
		FREQ[1:0] = 00b; MWBE=1		19.5 ±0.5		kHz			
4	Frequency of PWM cycles	FREQ[1:0] = 01b; MWBE=0		30		kHz			
fрwм	Frequency of FWW cycles	FREQ[1:0] = 01b; MWBE=1		29.2 ±0.8		kHz			
		FREQ[1:0] = 1xb; MWBE=0		40		kHz			
		FREQ[1:0] = 1xb; MWBE=1		39 ±1		kHz			
		VS = 13.5 V, SR[1:0] = 11		0.9		μs			
too	Cross current protection	VS = 13.5 V, SR[1:0] = 10		1.2		μs			
tcc	time	VS = 13.5 V, SR[1:0] = 01		1.8		μs			
		VS = 13.5 V, SR[1:0] = 00		4.8		μs			
	Current comparators blanking time	Tested by scan chain SR[1:0]=11, TBE=0		1		μs			
		Tested by scan chain SR[1:0]=11, TBE=1		4		μs			
		Tested by scan chain SR[1:0]=10, TBE=0		1.2		μs			
t _B		Tested by scan chain SR[1:0]=10, TBE=1		4		μs			
		Tested by scan chain SR[1:0]=01, TBE=0		1.8		μs			
		Tested by scan chain SR[1:0]=01, TBE=1		4		μs			
		Tested by scan chain SR[1:0] = 00		4.0		μs			
		Tested by scan chain FT[1:0]=00, FTOCE=0		0.5		μs			
		Tested by scan chain FT[1:0]=00, FTOCE=1		0.7		μs			
t⊧⊤	Current comparators filter time for current regulation	Tested by scan chain FT[1:0]=01, FTOCE=0		1		μs			
SI I	loop	Tested by scan chain FT[1:0]=01, FTOCE=1		1.2		μs			
		Tested by scan chain FT[1:0]=10, FTOCE=0		2		μs			
		Tested by scan chain FT[1:0]=10, FTOCE=1		2.2		μs			

Symbol	Parameter	Test condition	Min.	Тур.	Max.	Unit
		Tested by scan chain FT[1:0]=11, FTOCE=0		3		μs
		Tested by scan chain FT[1:0]=11, FTOCE=1		3.2		μs
400	Overcurrent filter delay time	Tested by scan chain FTOCE=0		0.2	0.2+ 1xtclock	μs
tOC Overcuri	Overcurrent litter delay time	Tested by scan chain FTOCE=1		0.4	0.4+ 1xtclock	μs
		VS = 13.5 V, SR[1:0] = 11		100		V/µs
VSR	Slew rate (dV/dt 30% - 70%) at HS and LS switches with	VS = 13.5 V, SR[1:0] = 10		70		V/µs
resistive load of 18Ω ;		VS = 13.5 V, SR[1:0] = 01		40		V/µs
	VS = 13.5 V, SR[1:0] = 00		10		V/µs	

Table 15: Clock characteristics

Symbol	Parameter	Test condition	Min.	Тур.	Max.	Unit
fsys	System clock frequency		_	10	_	MHz

Table 16: Digital inputs CTRL1, CTRL2, CTRL3, EN

Symbol	Parameter	Test condition	Min.	Тур.	Max.	Unit
V _{INL}	Input voltage low threshold				8.0	V
VINH	Input voltage high threshold		2.0			٧
V_{INHY}	Input hysteresis		0.2	0.4		٧
lin	Input pull down current	$V_{IN} = 2.0 \text{ V}$	5	30	60	μΑ
RINEN	Input pull down resistance at input EN		50	100	200	kΩ
tstart	Device starting time after EN is set (charge pump powered-up and SPI registers accessible)				1.5	ms

Table 17: Coil voltage acquisition

Symbol	Parameter	Test condition	Min.	Тур.	Max.	Unit
VCVIN	Coil voltage measurement range				28	V
VCVRES	ADC LSB resolution	6 V ≤ V _S ≤ 27 V		27		mV
CVA	Coil voltage measurement total unadjusted error	6 V ≤ V _S ≤ 27 V		±3		LSB

The coil voltage is sampled with 10 bit resolution in the range from 0 V to 24 V.

Table 18: Digital outputs DOUT1, DOUT2

Symbol	Parameter	Test condition	Min.	Тур.	Max.	Unit
VOUTL	Output low level	I _{OUT} = 4mA		0.2	0.5	V
VOUTH	Output high level	I _{OUT} = -4mA	VDD-0.5	VDD-0.2		V
ILK	Output leakage current		-1		1	μΑ

4.6 SPI bus (CSN, SCK, SDI, SDO)

Figure 27: SPI transfer timing diagram

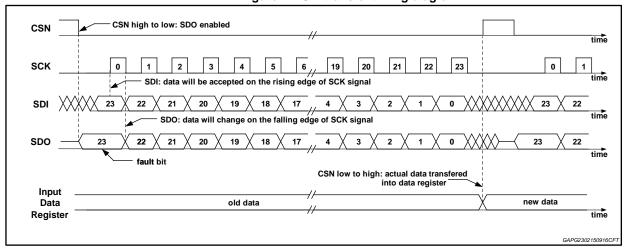


Table 19: CSN, SCK, SDI input

Symbol	Parameter	Test condition	Min.	Тур.	Max.	Unit
VINL	Input voltage low threshold				0.8	V
VINH	Input voltage high threshold		2.0			V
VINHY	Input hysteresis		0.2	0.4		V
RINCSN	CSN pull up resistor	V _{IN} = 0.8 V	50	100	200	kΩ
IINSCK	SCK pull down current	V _{IN} = 2.0 V	5	30	60	μΑ
IINSDI	SDI pull down current	V _{IN} = 2.0 V	5	30	60	μΑ

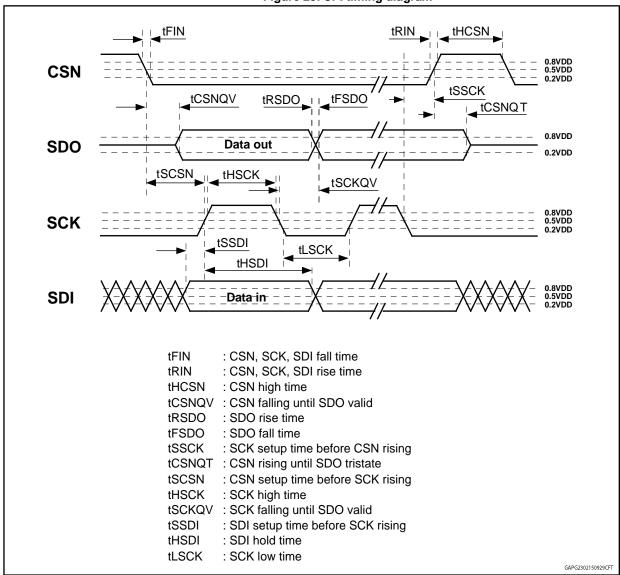
Table 20: SDO output

Symbol	Parameter	Test condition Min.		Тур.	Max.	Unit
VOUTL	Output low level	I _{OUT} = 4 mA		0.2	0.5	V
VOUTH	Output high level	I _{OUT} = -4 mA	VDD-0.5	VDD-0.2		٧
ILK	Output leakage current		-1		1	μA

Table 21: SPI timing

Tuble 21. Of Fulling									
Symbol	Parameter	Test condition	Min.	Тур.	Max	Unit			
tsck	Serial clock period		250			ns			
thsck	SCK high time		100			ns			
tLSCK	SCK low time		100			ns			
t _{RIN}	CSN, SCK, SDI rise time	f _{SCK} = 4 MHz			25	ns			
t _{FIN}	CSN, SCK, SDI fall time	f _{SCK} = 4 MHz			25	ns			
thcsn	CSN high time		6			μs			
tscsn	CSN setup time, CSN low before SCK rising		100			ns			
tssck	SCK setup time, SCK low before CSN rising		100			ns			
t _{SSDI}	SDI setup time before SCK rising		25			ns			
thsdi	SDI hold time		25			ns			
tcsnqv	CSN falling until SDO valid	$C_{OUT} = 50 \text{ pF};$ $I_{OUT} = \pm 1 \text{ mA}$			100	ns			
tscnqt	CSN rising until SDO tristate	Соит = 50 pF; Іоит = ±4 mA			100	ns			
t sckqv	SCK falling until SDO valid	Соит = 50 pF			60	ns			
t _{RSDO}	SDO rise time	Соит = 50 pF; I _{OUT} = -1 mA		50	100	ns			
t _{FSDO}	SDO fall time	Соит = 50 pF; louт = 1 mA		50	100	ns			
tcsnlto	CSN low timeout		20	35	50	ms			

Figure 28: SPI timing diagram



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5 ST SPI protocol

The ST-SPI is a standard used in ST Automotive ASSP devices. Therefore the here standardized SPI is described from SPI-Slave-Device point of view.

The ST-SPI will allow usage of generic software to operate the devices while maintaining the required flexibility to adapt it to the individual functionality of a particular product. In addition to that, failsafe mechanisms are implemented to protect the communication from external influences and wrong or unwanted usage.

5.1 **Physical layer**

CSN SCK L99SM81V μC SDI **SPI Master SPI Slave** SDO GADG1605171116P

Figure 29: SPI pin description

The physical layer description can be found in the functional description Section 2.14: "Serial peripheral interface (ST SPI standard)" and in the electrical characteristics Section 4.6: "SPI bus (CSN, SCK, SDI, SDO)"

L99SM81V ST SPI protocol

5.2 Protocol

5.2.1 SDI frame

The data-in frame consists of 24 bits (OpCode + Address + Data).

The first two transmitted bits (MSB, MSB-1) contain the Operation Code which represents the instruction to be performed. The following 6 bits (MSB-2 to MSB-7) represent the address on which the operation will be performed.

The subsequent 16 bits contain the payload data.

Figure 30: SDI frame

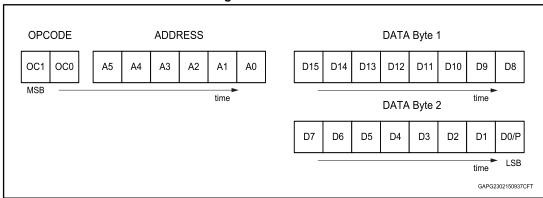


Table 22: Operation codes

OC1	OC0	Description
0	0	Write Operation
0	1	Read Operation
1	0	Read & Clear Operation
1	1	Read Device Information

The operation code is used to distinguish between different access modes to the registers of the slave device.

A Write Operation will lead to a modification of the addressed data by the payload if a write access is allowed (e.g. Control Register, valid data). Besides this a shift out of the content (data present at Communication Start) of the registers is performed.

A Read Operation shifts out the data present in the addressed register at Communication Start. The payload data will be ignored and internal data will not be modified. In this device a Burst Read can be performed.

A Read & Clear operation will lead to a clear of the addressed status bits. The bits to be cleared are defined first by address and secondly by the payload bits set to '1'. Besides this a shift out of the content (data present at Communication Start) of the registers is performed.



Status registers which change status during communication could be cleared by the current Read & Clear Operation and are neither reported in the current communication nor in the following communications. To avoid a loss of any reported status it is recommended to clear selectively the bits of the status registers, coherently with what reported in previous communications.

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Followed by the two OpCode bits, the six address bits are a fixed part of the communication frame. The six address bits, in combination with the OpCode, give access to a 2x64 word wide address range.

Table 23: Device application access

Operating code							
OC1 OC0							
0	0						
0	1						
1	0						

Table 24: Device information read access

Operating code						
OC1	OC0					
1	1					

Table 25: Address range

Address	Data	Туре		Address	Data	Туре			
3FH	Advanced operation code			3FH	Advanced operation code				
3EH		R/W or C		3EH	<gsb options=""></gsb>	R			
				11H	<wd type=""></wd>	R			
				10H		R			
				03H	<device 2="" number=""></device>	R			
				02H	<device 1="" number=""></device>	R			
				01H	<device family=""></device>	R			
00H		R/W or C		00H	<company code=""></company>	R			

The data contained in the Device Information address range is predefined by the ST SPI standard. The data is read-only and represents device-specific data like Device ID and SPI settings.

Besides the separate writing of all control registers and the bitwise clearing of all status registers, there are two Advanced Operation Codes that can be used to set all control registers to their default value and to clear all status registers.

A 'set all control registers to default' command is performed when an OpCode '11' at address b'111111 is performed.



Please consider that potential device-specific write-protected registers cannot be cleared with this command and therefore a device Power-On-Reset is needed.

A 'clear all status registers' command is performed when an OpCode '10' at address b'111111 is performed.

The Payload (data byte 1 to data byte 2) is the data transferred to the slave device with every SPI communication. The Payload always follows the OpCode and the Address bits.

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For write access the Payload represents the new data written to the address registers. For Read & Clear operations the Payload indicates the clearing of specific bit in a Status Register in case of a '1' at the corresponding bit position.

For a Read Operation the Payload is not used. For functional safety reasons it is recommended to set unused Payload to '0'.

5.2.2 SDO Frame

The Data-Out Frame consists of 24 bits (GSB+Data).

The first eight transmitted bits contain device-related status information and are latched into the shift register at the time of the Communication Start. These 8 bits are transmitted at every SPI transaction.

The subsequent bytes contain the payload data and are latched into the shift register with the eighth positive SCK edge. This could lead to an inconsistency of data between the GSB and Payload due to different shift register load times. Anyhow, no unwanted Status Register clear should appear, as status information should just be cleared with a dedicated bit clear after read.

DATA Byte 1 Global Status Byte (GSB) D15 D14 D13 D12 D11 D10 D9 D8 GSBN RSTB SPIE PLE FΕ DE GW FS MSB time time DATA Byte 2 D7 D6 D5 D4 D3 D2 D0/P D1 time GAPG2302150949CFT

Figure 31: SDO frame

The Global Status Byte is described here below.

The Payload (DATA Byte 1 & 2) is the data transferred from the slave device with every SPI communication to the microcontroller. The Payload always follows the OpCode and the Address bit of the actual shifted in data (In-Frame-Response).

5.2.2.1 Global Status Byte GSB

Table 26: Global Status Byte GSB

SDO frame: Global Status Byte										
	Bit 23 Bit 22 Bit 21 Bit 20 Bit 19 Bit 18 Bit 17 Bit									
Bit name	GSBN	RSTB	SPIE	-	FE	DE	GW	-		
Default	1	0	0	0	0	0	0	0		
Access	R	R	R	R	R	R	R	R		

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Table 27: Global Status Byte GSB (bit description)

SDO		Table 27: Global Status Byte GSB (bit description)
frame	Name	Description
Bit 23	GSBN	Global Status Bit Not The GSBN is a logically NOR combination of Bit 0 to Bit 6. This bit can also be used as Global Status Flag without starting a complete communication frame as it is present directly after pulling CSN low. GSBN = 1 (No Error) GSBN = 0 (Error)
Bit 22	RSTB	Reset Bit RSTB is set to one after any POR (either VDD POR or Vreg POR), it is reset after first valid SPI transfer
Bit 21	SPIE	SPI Error The SPIE is a logical OR combination of errors related to a wrong SPI communication. Beside the SCK count and SDI stuck at errors, also the parity error is reported here. The SPIE is automatically cleared by a valid SPI communication.
Bit 20	-	Reserved
Bit 19	FE	Functional Error The FE is a logical OR combination of errors coming from application specific functional items: Overcurrent outputs status bits (OC) Voltage regulator V5V Overvoltage (V5VOV) Voltage regulator V5V Short (V5VUV) Stall Detection (SDF)
Bit 18	DE	Device Error The DE is a logical OR combination of errors related to device specific blocks. For the L99SM81V this includes Overvoltage status bits (VSOV, VREGOV) Undervoltage status bit (VSUV) Charge Pump Fail status bit (CPFAIL) Thermal shutdown status bit (TSD)
Bit 17	GW	Global Warning The GW is a logical OR combination of all warning flags: VREG Undervoltage warning (VREGUV) Voltage Regulator V5V undervoltage warning (V5UVW) Thermal warning (TW) Open Load (OL)
Bit 16	-	Reserved

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5.3 Address and data definition

5.3.1 Device Information Register

The Device Information Register can be read by using OpCode '11'. After shifting out the GSB, the 8-bit wide payload will be transmitted. After shifting out the GSB followed by the 8-bit wide payload, a series of '0' are shifted out at the SDO pin.

Table 28: Device information read access operation code

Operating code						
OC1	OC0					
1	1					

Table 29: Device information registers

Table 29: Device information registers										
Address	Data	Туре	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
3FH	<advanced option=""></advanced>									
3EH	<gsb options=""></gsb>	R	0	0	0		Maskir	ng bits fo	or GSB	
20H	<spi cpha<br="">test></spi>	R	0	1	0	1	0	1	0	1
1FH	<wd 14="" bit="" pos.="">opt.</wd>	R								
		R								
14H	<wd 2="" bit="" pos.="">opt.</wd>	R				Not	used			
13H	<wd 1="" bit="" pos.="">opt.</wd>	R				NOL	useu			
12H	<wd 2="" type=""></wd>	R								
11H	<wd 1="" type=""></wd>	R								
10H	<spi mode=""></spi>	R		F	Please re	efer to se	ection "S	PI mode	e"	
		R								
0AH	<silicon version=""></silicon>	R	Major	silicon c n	hange re o.	evision	Minor	silicon c n	hange re o.	evision
09H	<device 8="" number=""></device>	R				00)H			
08H	<device 7="" number=""></device>	R				00)H			
07H	<device 6="" number=""></device>	R				00)H			
06H	<device 5="" number=""></device>	R				00)H			
05H	<device 4="" number=""></device>	R				04	1H			
04H	<device 3="" number=""></device>	R				4/	λH			
03H	<device 2="" number=""></device>	R	41H							
02H	<device 1="" number=""></device>	R	55H							
01H	<device family=""></device>	R	01H							
00H	<company code=""></company>	R	00Н							

The Device Identification Registers (00H \rightarrow 0AH) represent a unique number identifying device part-number.

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By reading out the <SPI Mode> register, general information of SPI usage of the Device Application Registers can be read.

Table 30: SPI mode

Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
BR	DL2	DL1	DL0	0	0	S1	S0

Table 31: SPI Burst Read

Bit 7	Description
0	BR disabled
1	BR enabled

The SPI Burst Read bit indicates if a burst read operation is implemented. The intention of a Burst Read is e.g. used to perform a device internal memory dump to the SPI Master.

The start of the Burst Read is like a normal Read Operation. The difference is that after the SPI Data Length the CSN is not pulled high and the SCK will be continuously clocked. When the normal SCK max count is reached (SPI Data Length), the consecutive addressed data will be latched into the shift register. This procedure is performed every time when the SCK payload length is reached.

In case the automatic increment address is not used by the device, undefined data is shifted out. An automatic address overflow is implemented when address 3FH is reached.

The SPI Burst Read is limited by the CSN low timeout.

The L99SM81V features SPI Burst Read.

The SPI Data Length value indicates the length of the SCK count monitor which is running for all accesses to the Device Application Register. In case of a communication frame with an SCK count not equal to the reported one, this will lead to a SPI Error and the data will be rejected.

Table 32: SPI data length

			•
Bit 6	Bit 5	Bit 4	Description
DL2	DL1	DL0	
0	0	0	Invalid
0	0	1	16-bit SPI
0	1	0	24-bit SPI
1	1	1	64-bit SPI

The default frame size of the L99SM81V is 24 bits, so the SPI Data Length bits are read as '010'.

Table 33: SPI data consistency check

Bit 1	Bit 0	Description
S1	S0	
0	0	Not used
0	1	Parity used
1	0	CRC used

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Bit 1	Bit 0	Description
1	1	Invalid

For the L99SM81V, a Data Consistency Check by parity check is implemented, therefore these bits are read as '01'. An odd parity bit is used and it is calculated over the complete communication frame.

The GSB Options byte indicates that device-specific status information is used instead of the predefined one. In case a bit of the GSB is not used, it has to be fixed to '0' value and is indicated by a logical '1' in the GSB Options byte.

5.3.2 Device Application Registers

The Device Application Registers are all registers accessible using OpCode '00', '01' and '10'.

An access to an unused address will not lead to any error, but should be prevented. Any data read from an unused address is not defined.

5.4 Protocol failure detection

To realize a protocol which fulfills certain failsafe requirements, a basic set of failure detection mechanisms is implemented.

5.4.1 Clock monitor

During communication (CSN low to high phase) a clock monitor counts the valid SCK clock edges. If the SCK edges do not correlate with the SPI Data Length, an SPIE is reported with the next command and the current communication is rejected.

By accessing the Device Information Registers (OpCode = '11'), the Clock Monitor is set to a minimum of 16 SCK edges plus a multiple of 8 (e.g. 16, 24, 32).

Providing no SCK edge during a CSN low to high phase is not recognized as an SPIE. For a SPI Burst Read also the SPI Data Length plus multiple number of Payload SCK edges are assumed as a valid communication.

5.4.2 SCK Polarity (CPOL) check

To detect wrong polarity access on SCK, the internal clock monitor is used. Providing first a negative edge on SCK during communication (CSN low to high phase) or a positive edge at last will lead to an SPI Error being reported in the next communication and the current data is rejected.

5.4.3 SCK Phase (CPHA) check

To verify that the SCK phase of the SPI master is set correctly a special Device Information Register is implemented. By reading this register the data must be 55H. In case AAH is read, the CPHA setting of the SPI master is wrong and a proper communication cannot be guaranteed.

5.4.4 CSN timeout

By pulling CSN low, the SDO is set active and leaves the tri-state condition. To ensure communication between other SPI devices within the same bus even in case of CSN stuck at low, a CSN timeout is implemented. By pulling CSN low, an internal timer is started. After the timer end is reached, the current communication is rejected and the SDO is set to tri-state condition. This error is not reported in any specific status register.

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5.4.5 Data Stuck

SDI stuck at GND

As a command with all data bits set to '0' and OpCode '00' on address b'000000 cannot be distinguished from an SDI stuck-at-GND error, this command is not allowed. In case a stuck-at-GND error is detected, the communication will be rejected and the SPIE will be set in the next communication cycle.

SDI stuck at HIGH

As a command with all data bits set to '1' and OpCode '11' on address b'111111 cannot be distinguished from an SDI stuck-at-HIGH error, this command is not allowed. In case a stuck-at-HIGH error is detected, the communication will be rejected and the SPIE will be set in the next communication cycle.

SDO stuck

SDO stuck-at-GND and stuck-at-HIGH errors have to be detected by the SPI master. As the definition of the GSB guarantees at least one bit toggle, a GSB with all bits set to '0' or with all bits set to '1' can be considered as an SDO stuck-at error.

5.5 Implementation remarks

5.5.1 Register change during communication

From an implementation point of view, it is guaranteed that no register change gets lost during communication. In case a register value was changed during a communication, it will be reported with the next communication frame.

5.5.2 GSB and Payload inconsistency

Due to the internal implementation strategy, it may occur that data reported in the GSB does not match data reported in the payload in case the data was changed during GSB shift out. In this case, the payload data is the status quo, as it was loaded later into the SPI shift register.

5.6 Timings

All SPI related timings are defined in Section 4.6: "SPI bus (CSN, SCK, SDI, SDO)".

6 SPI registers

6.1 Register map overview

Table 34: Complete device SPI register table

Address									Bit	100 01 11								
Hex	Name	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	Access
0x01	GSR	VSOV	VSUV	VREGOV	VREGUV	_	CPFAIL	V5UVW	V5VOV	V5VUV	TW	TSD	OL	ОС	SDF	_	Р	R/C
0x02	MSR	OCA1HS	OCA1LS	OCA2HS	OCA2LS	OCB1HS	OCB1LS	OCB2HS	OCB2LS	OLA	OLB	_	_	CVULF	CVLLAF	CVLLBF	Р	R
0x03	GCR1	CPWBE	MWBE	_	AOUT1	AOUT0	V5VE	_	_	_	_	MX1	_	MX2	MX3_1	MX3_0	Р	R/W
0x04	GCR2	_	_	_	_	DOUT11	DOUT10	_	DOUT21	DOUT20	_	_	_	_	_	_	Р	R/W
0x05	MCR1	ME	HOLDM	ASM2	ASM1	ASM0	SM2	SM1	SM0	DIR	PH5	PH4	PH3	PH2	PH1	PH0	Р	R/W
0x06	MCR2	FREQ1	FREQ0	FTOCE	TBE	FT1	FT0	SR1	SR0	DMR1	DMR0	SDAFW	SDBFW	OLDLY	DMH	_	Р	R/W
0x07	MCR3	CVE	_	D4	D3	D2	D1	D0	SD2	SD1	SD0	CVLUR1	CVLUR0	AHMSD	_	_	Р	R/W
0x08	MCREF	HC3	HC2	HC1	HC0	_	_	_	_	_	_	_	CA3	CA2	CA1	CA0	Р	R/W
0x09	MCVA	_	_	_	_	_	CV9	CV8	CV7	CV6	CV5	CV4	CV3	CV2	CV1	CV0	Р	R
0x0A	MCVB	_	_	_	_	_	CV9	CV8	CV7	CV6	CV5	CV4	CV3	CV2	CV1	CV0	Р	R
0x0B	MCVC	_	_	_	_	_	CV9	CV8	CV7	CV6	CV5	CV4	CV3	CV2	CV1	CV0	Р	R
0x0C	MCVD	_	_	_	_	_	CV9	CV8	CV7	CV6	CV5	CV4	CV3	CV2	CV1	CV0	Р	R
0x0D	MCVLLB	_	_	_	_	_	CVLLB9	CVLLB8	CVLLB7	CVLLB6	CVLLB5	CVLLB4	CVLLB3	CVLLB2	CVLLB1	CVLLB0	Р	R/W
0x0E	MCVLLA	_	_	_	_	_	CVLLA9	CVLLA8	CVLLA7	CVLLA6	CVLLA5	CVLLA4	CVLLA3	CVLLA2	CVLLA1	CVLLA0	Р	R/W
0x0F	MCVUL	_	_	_	_	_	CVUL9	CVUL8	CVUL7	CVUL6	CVUL5	CVUL4	CVUL3	CVUL2	CVUL1	CVUL0	Р	R/W



6.2 Global Status Register GSR (0x01)

Table 35: Global Status Register GSR

	Global Status Register (0x01)									
	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8		
Bit name	VSOV	VSUV	VREGOV	VREGUV	_	CPFAIL	V5UVW	V5VOV		
Default	0	0	0	0	0	0	0	0		
Access	R/C	R/C	R/C	R/C	R	R/C	R/C	R/C		
	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0		
Bit name	V5VUV	TW	TSD	OL	ОС	SDF	_	Р		
Default	0	0	0	0	0	0	0	_		
Access	R/C	R/C	R/C	R/C	R/C	R/C	R	_		

Table 36: Global Status Register GSR (bit description)

	Name	Table 36: Global Status Register GSR (bit description)
	Name	Description
Bit 15	VSOV	VS Overvoltage error flag
		When set, it indicates an over-voltage error on VS supply.
Bit 14	VSUV	VS Undervoltage error flag
	,,,,,	When set, it indicates an under-voltage error on VS supply.
Bit 13	VREGOV	VREG Overvoltage error flag
Dit 10	VILLOUV	When set, it indicates an over-voltage error on V _{REG} supply.
Bit 12	VREGUV	VREG Undervoltage warning flag
DIL 12	VICEGOV	When set, it indicates an under-voltage warning on V _{REG} supply.
Bit 11	_	Reserved
D:+ 40	CDEAU	Charge pump error Flag
Bit 10	CPFAIL	Indicates that safe operation of charge pump cannot be guaranteed
D:4 0	\(\(\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	V5V Regulator Undervoltage Warning Flag
Bit 9	V5UVW	Indicates that V5V output voltage is below V5V under-voltage warning threshold
D:+ 0	\/5\/O\/	V5V Regulator Overvoltage Error Flag
Bit 8	V5VOV	Indicates that V5V output voltage exceeds V5V overvoltage error threshold
D:4.7	\/ 5 \/ \/	V5V Regulator Undervoltage Error Flag
Bit 7	V5VUV	Indicates that V5V output voltage droped below V5V undervoltage error threshold
D:+ 0	T) A /	Thermal Warning Flag
Bit 6	TW	Indicates that device temperature exceeds thermal warning threshold
D); 5	TOD	Thermal Shutdown Error Flag
Bit 5	TSD	Indicates that device temperature exceeds thermal shutdown threshold
		Open Load Warning Flag
Bit 4	OL	This bit is set as soon as either OLA or OLB bit in MSR is set. Clearing this bit
		automatically results in the clearing of OLA and OLB in MSR
		Overcurrent Error Flag
Bit 3	oc	This bit is set as soon as any of the bits [15:8] of MSR is set. Clearing this bit
		automatically results in the clearing of bits [15:8] in MSR.

	Name	Description
Bit 2	SDF	Stall detection Flag This bit is set if CVE is set and sampled coil voltage is out of the range [CVLLAx; CVULx] for a number of consecutive acquisitions (zero current steps) equal to SD[2:0]
Bit 1	_	Reserved
Bit 0	Р	Parity bit

6.3 Motor and driver Status Register MSR (0x02)

Table 37: Motor and driver Status Register MSR

	Motor and driver Status Register (0x02)									
	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8		
Bit name	OCA1HS	OCA1LS	OCA2HS	OCA2LS	OCB1HS	OCB1LS	OCB2HS	OCB2LS		
Default	0	0	0	0	0	0	0	0		
Access	R	R	R	R	R	R	R	R		
	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0		
Bit name	OLA	OLB	_	_	CVULF	CVLLAF	CVLLBF	Р		
Default	0	0	0	0	0	0	0			
Access	R	R	R	R	R	R	R	_		

Table 38: Motor and driver Status Register MSR (bit description)

	Name	Description
Bit 15	OCA1HS	Overcurrent Output A1 High Side Switch Error Flag Indicates overcurrent situation in high side switch of output A1 This bit is automatically cleared by clearing OC bit in GSR
Bit 14	OCA1LS	Overcurrent Output A1 Low Side Switch Error Flag Indicates overcurrent situation in low side switch of output A1 This bit is automatically cleared by clearing OC bit in GSR
Bit 13	OCA2HS	Overcurrent Output A2 High Side Switch Error Flag Indicates overcurrent situation in high side switch of output A2 This bit is automatically cleared by clearing OC bit in GSR
Bit 12	OCA2LS	Overcurrent Output A2 Low Side Switch Error Flag Indicates overcurrent situation in low side switch of output A2 This bit is automatically cleared by clearing OC bit in GSR
Bit 11	OCB1HS	Overcurrent Output B1 High Side Switch Error Flag Indicates overcurrent situation in high side switch of output B1 This bit is automatically cleared by clearing OC bit in GSR
Bit 10	OCB1LS	Overcurrent Output B1 Low Side Switch Error Flag Indicates overcurrent situation in low side switch of output B1 This bit is automatically cleared by clearing OC bit in GSR
Bit 9	OCB2HS	Overcurrent Output B2 High Side Switch Error Flag Indicates overcurrent situation in high side switch of output B2 This bit is automatically cleared by clearing OC bit in GSR
Bit 8	OCB2LS	Overcurrent Output B2 Low Side Switch Error Flag Indicates overcurrent situation in low side switch of output B2 This bit is automatically cleared by clearing OC bit in GSR
Bit 7	OLA	Openload Phase A Warning Flag Indicates that current reference for phase A has not been reached within the programmed delay. This bit is automatically cleared by clearing OL bit in GSR

	Name	Description
Bit 6	OLB	Openload Phase B Warning Flag Indicates that current reference for phase B has not been reached within the programmed delay. This bit is automatically cleared by clearing OL bit in GSR
Bit 5		Reserved
Bit 4	_	Reserved
Bit 3	CVULF	Coil Voltage Upper Limit Flag This bit will be updated automatically if the CVE coil voltage enable bit in the motor control register 3 MCR3 is set. It will be set if sampled coil voltage exceeds the limit defined as upper limit (CVUL[9:0]), it will be reset otherwise
Bit 2	CVLLAF	Coil Voltage Lower Limit 1 Flag This bit will be automatically updated if the CVE coil voltage enable bit in the motor control register 3 MCR3 is set. It will be set if sampled coil voltage underruns the limit defined as lower limit A (CVLLA[9:0]), it will be reset otherwise
Bit 1	CVLLBF	Coil Voltage Lower Limit 2 Flag This bit will be automatically updated if the CVE coil voltage enable bit in the motor control register 3 MCR3 is set. It will be set if sampled coil voltage underruns the limit defined as lower limit B (CVLLB[9:0]), it will be reset otherwise
Bit 0	Р	Parity bit

6.4 Global Configuration Register 1 GCR1 (0x03)

Table 39: Global Configuration Register 1 GCR1

	Table of Ground Coming and Art Control of Co									
	Global Configuration Register 1 (0x03)									
	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8		
Bit name	CPWBE	MWBE	_	AOUT1	AOUT0	V5VE	_	_		
Default	0	0	0	0	0	1	0	0		
Access	R/W	R/W	R	R/W	R/W	R/W	R	R		
	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0		
Bit name	_	_	MX1	_	MX2	MX3_1	MX3_0	Р		
Default	0	0	1	0	1	0	0	_		
Access	R	R	R/W	R	R/W	R/W	R/W	_		

Table 40: Global Configuration Register 1 GCR1 (bit description)

	Name	Description
Bit 15	CPWBE	Charge Pump Wobble Frequency Enable 1 = Charge Pump with Spread Spectrum Feature 0 = Fixed Charge Pump Frequency
Bit 14	MWBE	Wobble Frequency Enable 1 = Frequency Generator with Spread Spectrum Feature 0 = Fixed PWM Frequency
Bit 13	_	Reserved
Bit 12	AOUT1	Analog Output selection
Bit 11	AOUT0	00 or 11 = Disabled 01 = Voltage proportional to junction temperature 10 = Band-gap voltage
Bit 10	V5VE	V5V Voltage Regulator Enable 1 = V5V Voltage Regulator enabled 0 = V5V Voltage Regulator disabled
Bit 9	_	Reserved
Bit 8	_	Reserved
Bit 7	_	Reserved
Bit 6	_	Reserved
Bit 5	MX1	CTRL1 Function Select If this bit is reset the CTRL1 pin is deactivated and phase counter can only be updated through SPI, if it is set the CTRL1 pin holds the STEP function (PH[5:0] bits in read-only)
Bit 4	_	Reserved
Bit 3	MX2	CTRL2 Function Select If this bit is reset the CTRL2 pin is deactivated, DIR bit can only be changed via SPI; if it is set the CTRL2 pin holds the DIR functionality and the DIR bit reflects CTRL2 logic level.
Bit 2	MX3_1	CTRL3 Function Select

	Name	Description
		00 or 11 = OFF
Bit 1	MX3_0	01 = SMODE
		10 = HOLD (see also Section 2.10: "Control pins (CTRLx)")
Bit 0	Р	Parity bit

6.5 Global Configuration Register 2 GCR2 (0x04)

Table 41: Global Configuration Register 2 GCR2

	Global Configuration Register 2 (0x04)									
	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8		
Bit name	_	_	_	_	DOUT11	DOUT10	_	DOUT21		
Default	0	0	0	0	0	0	0	0		
Access	R	R	R	R	R/W	R/W	R	R/W		
	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0		
Bit name	DOUT20	_	_	_	_	_	_	Р		
Default	0	0	0	0	0	0	0			
Access	R/W	R	R	R	R	R	R	_		

Table 42: Global Configuration Register 2 GCR2 (bit description)

	Name	Description
Bit 15	_	Reserved
Bit 14	_	Reserved
Bit 13	_	Reserved
Bit 12	_	Reserved
Bit 11	DOUT11	DOUT1 Function Select
Bit 10	DOUT10	00 = OFF; 01 = CVRDY; 10 = CVLL; 11 = CVRUN
Bit 9	_	Reserved
Bit 8	DOUT21	DOUT2 Function Select
Bit 7	DOUT20	00 = OFF; 01 = PWM; 10 = ERR; 11 = EC
Bit 6	_	Reserved
Bit 5	_	Reserved
Bit 4	_	Reserved
Bit 3	_	Reserved
Bit 2	_	Reserved
Bit 1	_	Reserved
Bit 0	Р	Parity bit

6.6 Motor Control Register 1 MCR1 (0x05)

Table 43: Motor Control Register 1 MCR1

Motor Control Register 1 (0x05)									
	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	
Bit name	ME	HOLDM	ASM2	ASM1	ASM0	SM2	SM1	SM0	
Default	0	0	0	0	0	0	0	0	
Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	
	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
Bit name	DIR	PH5	PH4	PH3	PH2	PH1	PH0	Р	
Default	0	0	0	0	0	0	0	_	
Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	_	

Table 44: Motor Control Register 1 MCR1 (bit description)

	Name	Description
Bit 15	ME	Motor Enable When this bit is reset all switches are off setting the outputs in high impedance state. When this bit is set, the outputs are controlled according to the selected operating mode.
Bit 14	HOLDM	HOLD mode 0: HOLD mode disabled 1: HOLD mode enabled If MX3 = 10b the bit is read-only and reflects CTRL3 input logic state. If SDF and AHMSD bits are set, then SDF must be cleared before HOLDM can be cleared
Bit 13	ASM2	Alternative Step Mode (active step mode if MX1 is set and MX3 = 01b and CTRL3 is high)
Bit 12	ASM1	000, 101, 110, 111: 1/16th microstep;
Bit 11	ASM0	001: 1/8th microstep; 010: ministep; 011: halfstep; 100: fullstep
Bit 10	SM2	Step Mode (active step mode in following cases: MX1 is set and MX3 is different from 01b;
Bit 9	SM1	MX1 is set and MX3 is equal to 01b and CRTL3 pin is low)
Bit 8	SM0	000, 101, 110, 111: 1/16th microstep; 001: 1/8th microstep; 010: ministep; 011: halfstep; 100: fullstep
Bit 7	DIR	Direction This bit defines the action to be taken when MX1 is set and a rising edge on input CTRL1 is detected: 0: increment phase counter 1: decrement phase counter If MX2 is reset, this bit can only be modified through SPI, if MX2 is set this bit can only be altered by CTRL2 pin and the status of this bit reflects the logic state of CTRL2 pin.

	Name	Description
Bit 6	PH5	
Bit 5	PH4	Step (Phase) Counter [50]
Bit 4	PH3	These bits reflect the applied angular step position ("000000" = 0°, "011111" = 180°) and determine the current profiles to be applied to the motor phases. The bits are read-only if
Bit 3	PH2	MX1 bit is set in GCR1 (see also Section 2.6: "Stepping modes and step update"). In case
Bit 2	PH1	bit MX1=0, a new Phase counter value (written by SPI) becomes effective and hence can be read via SPI only after the next PWM period begins
Bit 1	PH0	be road vid or rothly ditor the next r vvivi period begins
Bit 0	Р	Parity bit

6.7 Motor Control Register 2 MCR2 (0x06)

Table 45: Motor Control Register 2 MCR2

	Motor Control Register 2 (0x06)									
	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8		
Bit name	FREQ1	FREQ0	FTOCE	TBE	FT1	FT0	SR1	SR0		
Default	0	0	0	0	1	1	0	0		
Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W		
	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0		
Bit name	DMR1	DMR0	SDAFW	SDBFW	OLDLY	DMH	_	Р		
Default	0	0	0	0	0	0	0	_		
Access	R/W	R/W	R/W	R/W	R/W	R/W	R	_		

Table 46: Motor Control Register 2 MCR2 (bit description)

	Name	Description					
Bit 15	FREQ1	PWM Clock Frequency					
		00: 20kHz					
Bit 14	FREQ0	01: 30kHz					
		1x: 40kHz					
Bit 13	FTOCE	If this bit is set, both tFT and tOC filtering time are extended by two system clock cycles (200ns typical)					
Bit 12	TBE	If this bit is set, tB time is extended to 4us indipendently from SR[1:0] settings					
Bit 11	FT1	Current comparators output filter time					
		This filtering time t _{FT} is applied on current comparator output to avoid false triggering of current regulation loop					
Bit 10	ET0	00: 0.5μs					
Bit 10	FT0	01: 1.0μs					
		10: 2.0µs					
		11: 3.0µs					
Bit 9	SR1	Slew Rate					
		00: 10V/μs					
Bit 8	SR0	01: 40V/μs					
DIL 0		10: 70V/µs					
		11: 100V/μs					
Bit 7	DMR1	Decay Mode in RUN mode					
		00: Auto Decay mode 1					
Bit 6	DMR0	11: Auto Decay mode 2					
DIL 0	DIVIRU	01: Slow Decay Mode always applied					
		10: Mixed decay mode always applied					
		Slow Decay Freewheeling Path (Phase A)					
Bit 5	SDAFW	0: High Side Freewheeling					
		1: Low Side Freewheeling					
		Slow Decay Freewheeling Path (Phase B)					
Bit 4	SDBFW	0: High Side Freewheeling					
		1: Low Side Freewheeling					

	Name	Description
Bit 3	OLDLY	Open load detection time 0: 30ms 1: 60ms
Bit 2	DMH	Decay Mode in HOLD mode 0: Slow Decay Mode always applied 1: Mixed decay mode always applied
Bit 1	_	Reserved
Bit 0	Р	Parity bit

6.8 Motor Control Register 3 MCR3 (0x07)

Table 47: Motor Control Register 3 MCR3

	Motor Control Register 3 (0x07)									
	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8		
Bit name	CVE	_	D4	D3	D2	D1	D0	SD2		
Default	0	0	0	0	0	0	0	0		
Access	R/W	R	R/W	R/W	R/W	R/W	R/W	R/W		
	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0		
Bit name	SD1	SD0	CVLUR1	CVLUR0	AHMSD	_	_	Р		
Default	0	0	0	0	0	0	0	_		
Access	R/W	R/W	R	R	R/W	R	R	_		

Table 48: Motor Control Register 3 MCR3 (bit description)

	Name	Description						
		Coil Voltage Capture Enable						
Bit 15	CVE	If this bit is set coil voltage will be captured according to selected capture mode.						
		If this bit is cleared no voltage will be captured.						
Bit 14	_	Reserved						
Bit 13	D4	Coil Voltage Timing						
Bit 12	D3	This value represents the time - expressed in PWM periods - between the beginning of a						
Bit 11	D2	zero current step and the moment where the coil voltage is sampled. This number has to be greater than 1.						
Bit 10	D1	If D4D0 = '00000' then the voltage is automatically sampled at the end of the zero						
Bit 9	D0	current step.						
Bit 8	SD2	Stall detection bits						
Bit 7	SD1	If CVE bit is set, SD[2:0] represent the number of consecutive times the sampled coil						
Bit 6	SD0	voltage value has to be out of the range [CVLLAx; CVULx] before SDF bit is set. Depending on AHMSD bit, HOLD mode could also be automatically entered. Setting SD[2:0] to 000b is equivalent to 001b.						
Bit 5	CVLUR1	Coil voltage latest update register						
Dit 3	CVLOIN	It contains the pointer to latest update coil voltage register (MCVx)						
		00: MCVA						
Bit 4	CVLUR0	01: MCVB						
		10: MCVC						
		11: MCVD						
		Automatic HOLD mode on stall detection						
Bit 3	AHMSD	If this bit is set - as soon as a stall is detected setting the SDF bit - HOLDM bit is then automatically set and HOLD mode entered.						
		If this bit is reset, HOLD mode is not automatically entered (HOLDM bit not automatically set) on a stall detection event (SDF bit set).						
Bit 2	_	Reserved						
Bit 1	_	Reserved						
Bit 0	Р	Parity bit						

6.9 Motor current reference register MCREF (0x08)

Table 49: Motor current reference register MCREF

	Motor Current reference register (0x08)								
	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	
Bit name	HC3	HC2	HC1	HC0	_	_	_	_	
Default	0	0	0	0	0	0	0	0	
Access	R/W	R/W	R/W	R/W	R	R	R	R	
	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
Bit name	_	_	_	CA3	CA2	CA1	CA0	Р	
Default	0	0	0	0	0	0	0	_	
Access	R	R	R	R/W	R/W	R/W	R/W		

Table 50: Motor Current reference register MCREF (bit description)

	Name	Description
Bit 15	HC3	Full scale motor current in HOLD mode
Bit 14	HC2	Depending on the value of bits HC[3:0], the full scale current used in HOLD mode to generate
Bit 13	HC1	motor current references is changed according to data reported in the electrical
Bit 12	HC0	characteristics section of this document
Bit 11	_	Reserved
Bit 10	_	Reserved
Bit 9	_	Reserved
Bit 8	_	Reserved
Bit 7	_	Reserved
Bit 6	_	Reserved
Bit 5	_	Reserved
Bit 4	CA3	Full scale motor current in RUN mode
Bit 3	CA2	Depending on the value of bits CA[3:0], the full scale current used in RUN mode to generate
Bit 2	CA1	motor current references is changed according to data reported in the electrical
Bit 1	CA0	characteristics section of this document
Bit 0	Р	Parity bit

6.10 Motor Coil Voltage 0° MCVA (0x09)

Table 51: Motor Coil Voltage 0° MCVA

					··· · · · · · · · · · · · · · · · · ·				
	Motor Coil voltage 0° (0x09)								
	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	
Bit name	_	_	_	_	_	CV9	CV8	CV7	
Default	0	0	0	0	0	0	0	0	
Access	R	R	R	R	R	R	R	R	
	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
Bit name	CV6	CV5	CV4	CV3	CV2	CV1	CV0	Р	
Default	0	0	0	0	0	0	0	_	
Access	R	R	R	R	R	R	R	_	

Table 52: Motor Coil Voltage 0° MCVA (bit description)

	Name	Description
Bit 15	_	Reserved
Bit 14	_	Reserved
Bit 13	_	Reserved
Bit 12	_	Reserved
Bit 11	_	Reserved
Bit 10	CV9	
Bit 9	CV8	
Bit 8	CV7	
Bit 7	CV6	
Bit 6	CV5	Coil voltage digital value at 0°
Bit 5	CV4	Averaged coil voltage measurement corresponding to the micro-step with phase counter equal to 0. Full scale referred to maximum V _S operating range (28V)
Bit 4	CV3	5 - 1
Bit 3	CV2	
Bit 2	CV1	
Bit 1	CV0	
Bit 0	Р	Parity bit

6.11 Motor Coil Voltage 90° MCVB (0x0A)

Table 53: Motor Coil Voltage 90° MCVB

Motor Coil voltage 90° (0x0A)								
	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8
Bit name	_	_	_	_	_	CV9	CV8	CV7
Default	0	0	0	0	0	0	0	0
Access	R	R	R	R	R	R	R	R
	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Bit name	CV6	CV5	CV4	CV3	CV2	CV1	CV0	Р
Default	0	0	0	0	0	0	0	_
Access	R	R	R	R	R	R	R	_

Table 54: Motor Coil Voltage 90° MCVB (bit description)

	Table 54: Motor Coll Voltage 90° MCVB (bit description)							
	Name	Description						
Bit 15	_	Reserved						
Bit 14	_	Reserved						
Bit 13	_	Reserved						
Bit 12	_	Reserved						
Bit 11	_	Reserved						
Bit 10	CV9							
Bit 9	CV8							
Bit 8	CV7							
Bit 7	CV6							
Bit 6	CV5	Coil voltage digital value at 90°						
Bit 5	CV4	Averaged coil voltage measurement corresponding to the microstep with phase counter equal to 16. Full scale referred to maximum V _S operating range (28 V)						
Bit 4	CV3	3 cp - 1						
Bit 3	CV2							
Bit 2	CV1							
Bit 1	CV0							
Bit 0	Р	Parity bit						

6.12 Motor Coil Voltage 180° MCVC (0x0B)

Table 55: Motor Coil Voltage 180° MCVC

Motor Coil voltage 180° (0x0B)								
	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8
Bit name	_	_	_	_	_	CV9	CV8	CV7
Default	0	0	0	0	0	0	0	0
Access	R	R	R	R	R	R	R	R
	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Bit name	CV6	CV5	CV4	CV3	CV2	CV1	CV0	Р
Default	0	0	0	0	0	0	0	_
Access	R	R	R	R	R	R	R	_

Table 56: Motor Coil Voltage 180° MCVC (bit description)

	Name	Description
Bit 15	_	Reserved
Bit 14	_	Reserved
Bit 13	_	Reserved
Bit 12	_	Reserved
Bit 11	_	Reserved
Bit 10	CV9	
Bit 9	CV8	
Bit 8	CV7	
Bit 7	CV6	
Bit 6	CV5	Coil voltage digital value at 180°
Bit 5	CV4	Averaged coil voltage measurement corresponding to the micro-step with phase counter equal to 32. Full scale referred to maximum Vs operating range (28V)
Bit 4	CV3	5 quanto 5 = 1
Bit 3	CV2	
Bit 2	CV1	
Bit 1	CV0	
Bit 0	Р	Parity bit

6.13 Motor Coil Voltage 270° MCVD (0x0C)

Table 57: Motor Coil Voltage 270° MCVD

	Table of Fineter on Totage 2.0 move								
	Motor Coil voltage 270° (0x0C)								
	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	
Bit name	_	_	_	_	_	CV9	CV8	CV7	
Default	0	0	0	0	0	0	0	0	
Access	R	R	R	R	R	R	R	R	
	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
Bit name	CV6	CV5	CV4	CV3	CV2	CV1	CV0	Р	
Default	0	0	0	0	0	0	0	_	
Access	R	R	R	R	R	R	R	_	

Table 58: Motor Coil Voltage 270° MCVD (bit description)

	Name	Description
Bit 15	_	Reserved
Bit 14	_	Reserved
Bit 13	_	Reserved
Bit 12	_	Reserved
Bit 11	_	Reserved
Bit 10	CV9	
Bit 9	CV8	
Bit 8	CV7	
Bit 7	CV6	
Bit 6	CV5	Coil voltage digital value at 270°
Bit 5	CV4	Averaged coil voltage measurement corresponding to the micro-step with phase counter equal to 48. Full scale referred to maximum Vs operating range (28V)
Bit 4	CV3	
Bit 3	CV2	
Bit 2	CV1	
Bit 1	CV0	
Bit 0	Р	Parity bit

L99SM81V SPI registers

6.14 Motor Coil Voltage Low Limit B MCVLLB (0x0D)

Table 59: Motor Coil Voltage Low Limit B MCVLLB

	Motor Coil Voltage Low Limit B Register (0x0D)							
	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8
Bit name		_	_	_		CVLLB9	CVLLB8	CVLLB7
Default	0	0	0	0	0	0	0	0
Access	R	R	R	R	R	R/W	R/W	R/W
	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Bit name	CVLLB6	CVLLB5	CVLLB4	CVLLB3	CVLLB2	CVLLB1	CVLLB0	Р
Default	0	0	0	0	0	0	0	_
Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	_

Table 60: Motor Coil Voltage Low Limit B MCVLLB (bit description)

	Name	Description	
Bit 15	_	Reserved	
Bit 14	_	Reserved	
Bit 13	_	Reserved	
Bit 12	_	Reserved	
Bit 11	_	Reserved	
Bit 10	CVLLB9		
Bit 9	CVLLB8		
Bit 8	CVLLB7		
Bit 7	CVLLB6		
Bit 6	CVLLB5	Coil Voltage Lower Limit B	
Bit 5	CVLLB4	Lower threshold B for coil voltage value. CVLLBF bit is set if latest coil voltage measurement falls below this threshold, reset otherwise.	
Bit 4	CVLLB3		
Bit 3	CVLLB2		
Bit 2	CVLLB1		
Bit 1	CVLLB0		
Bit 0	Р	Parity bit	

SPI registers L99SM81V

6.15 Motor Coil Voltage Low Limit A MCVLLA (0x0E)

Table 61: Motor Coil Voltage Low Limit A MCVLLA

	ranic on motor con ronage zon zimmer mot zzer							
	Motor Coil Voltage Low Limit A Register (0x0E)							
	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8
Bit name	_	_	_	_	_	CVLLA9	CVLLA8	CVLLA7
Default	0	0	0	0	0	0	0	0
Access	R	R	R	R	R	R/W	R/W	R/W
	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Bit name	CVLLA6	CVLLA5	CVLLA4	CVLLA3	CVLLA2	CVLLA1	CVLLA0	Р
Default	0	0	0	0	0	0	0	_
Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	_

Table 62: Motor Coil Voltage Low Limit A MCVLLA (bit description)

	Name	Description
Bit 15	_	Reserved
Bit 14	_	Reserved
Bit 13	_	Reserved
Bit 12	_	Reserved
Bit 11	_	Reserved
Bit 10	CVLLA9	
Bit 9	CVLLA8	
Bit 8	CVLLA7	
Bit 7	CVLLA6	
Bit 6	CVLLA5	Coil Voltage Lower Limit A
Bit 5	CVLLA4	Lower threshold A for coil voltage value. CVLLAF bit is set if latest coil voltage measurement falls below CVLLA[9:0] threshold, reset otherwise.
Bit 4	CVLLA3	La agranta and a same
Bit 3	CVLLA2	
Bit 2	CVLLA1	
Bit 1	CVLLA0	
Bit 0	Р	Parity bit

L99SM81V SPI registers

6.16 Motor Coil Voltage Upper Limit MCVUL (0x0F)

Table 63: Motor Coil Voltage Upper Limit MCVUL

	Motor Coil Voltage Upper Limit Register (0x0F)							
	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8
Bit name	_	_	_	_	_	CVUL9	CVUL8	CVUL7
Default	0	0	0	0	0	1	1	1
Access	R	R	R	R	R	R/W	R/W	R/W
	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Bit name	CVUL6	CVUL5	CVUL4	CVUL3	CVUL2	CVUL1	CVUL0	Р
Default	1	1	1	1	1	1	1	_
Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	_

Table 64: Motor Coil Voltage Upper Limit MCVUL (bit description)

	Name	Description
Bit 15	_	Reserved
Bit 14	_	Reserved
Bit 13	_	Reserved
Bit 12	_	Reserved
Bit 11	_	Reserved
Bit 10	CVUL9	
Bit 9	CVUL8	
Bit 8	CVUL7	
Bit 7	CVUL6	
Bit 6	CVUL5	Coil Voltage Upper Limit
Bit 5	CVUL4	Upper threshold for coil voltage value. CVULF bit is set if latest coil voltage measurement exceeds CVUL[9:0] threshold, reset otherwise.
Bit 4	CVUL3	
Bit 3	CVUL2	
Bit 2	CVUL1	
Bit 1	CVUL0	
Bit 0	Р	Parity bit

Package information L99SM81V

7 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.

7.1 QFN40L package information

Figure 32: QFN40L package outline

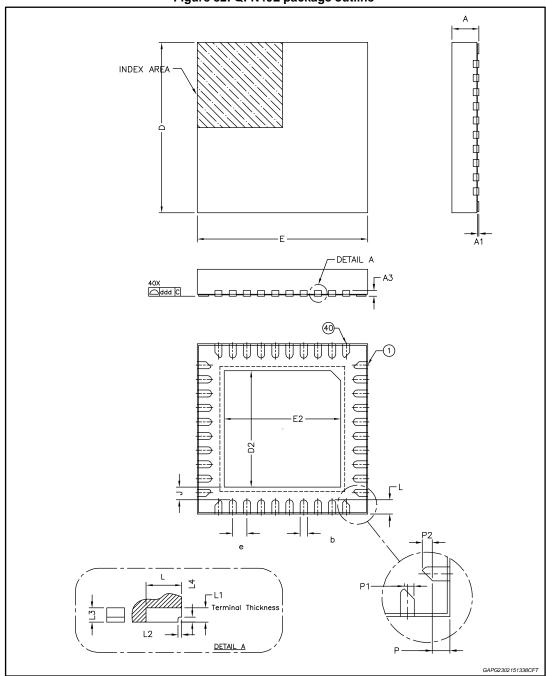


Table 65: QFN40L package mechanical data

	Dimensions Millimeters					
Ref.						
_	Min.	Тур.	Max.			
А	0.85	0.95	1.05			
A1	0		0.05			
A3		0.20				
b	0.20	0.25	0.30			
D	5.85	6.00	6.15			
Е	5.85	6.00	6.15			
D2	3.95	4.10	4.25			
E2	3.95	4.10	4.25			
е		0.50				
J		0.45				
L	0.40	0.50	0.60			
L1		0.20				
L2		0.05				
L3		0.20				
L4		0.075				
Р		0.31				
P1		0.18				
P2		0.18				
ddd			0.08			

7.2 PowerSSO-36 package information

Figure 33: PowerSSO-36 package outline

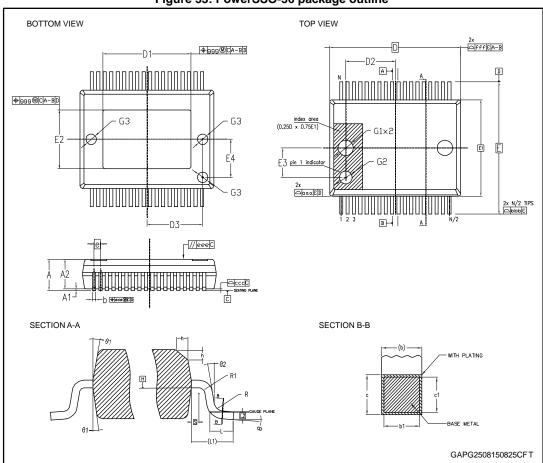


Table 66: PowerSSO-36 package mechanical data

	Dimensions					
Ref.	Millimeters					
	Тур.	Min.	Max.			
Θ	0°		8°			
Θ1	5°		10°			
Θ2	0°					
А	2.15		2.45			
A1	0.00		0.10			
A2	2.15		2.35			
b	0.18		0.32			
b1	0.13	0.25	0.30			
С	0.23		0.32			
c1	0.20	0.20	0.30			
D		10.30 BSC				
D1	4.9		5.5			

		Dimensions	rackage information		
Ref.		Millimeters			
	Тур.	Min.	Max.		
D2		3.65			
D3		4.30			
е		0.50 BSC	<u>.</u>		
Е		10.30 BSC			
E1		7.50 BSC			
E2	4.10		4.70		
E3		2.30			
E4		2.90			
G1		1.20			
G2		1.00			
G3		0.80			
h	0.30		0.40		
L	0.55	0.70	0.85		
L1		1.40			
L2		0.25 BSC			
N		36			
R	0.30				
R1	0.20				
S	0.25				
	Tolerance	of form and position			
aaa		0.20			
bbb		0.20			
ccc	0.10				
ddd	0.20				
eee		0.10			
ffff		0.20			
999		0.15			

7.3 Marking information

Figure 34: QFN40L marking information

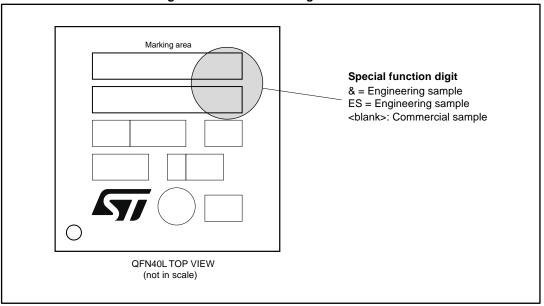
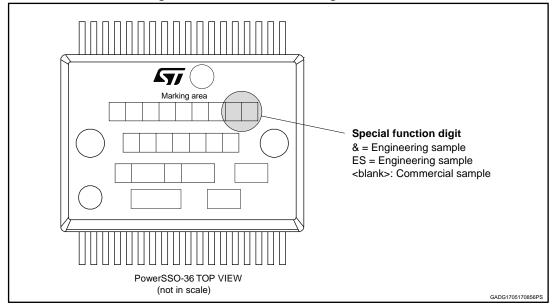


Figure 35: PowerSSO-36 marking information



Parts marked as '&' or 'ES' are not yet qualified and therefore not approved for use in production. ST is not responsible for any consequences resulting from such use. In no event will ST be liable for the customer using any of these engineering samples in production. ST's Quality department must be contacted prior to any decision to use these engineering samples to run a qualification activity.

L99SM81V Order codes

8 Order codes

Table 67: Device summary

Order code	Package	Packing
L99SM81VQ6TR	QFN40L	Tape and reel
L99SM81VYTR	PowerSSO-36	Tape and reel

Revision history L99SM81V

9 Revision history

Table 68: Document revision history

Date	Revision	Changes
04-Mar-2015	1	Initial release.
19-Oct-2015	2	Updated Section "Features" Updated following sections: Section 2: "Device description" Section 5.2.2.1: "Global Status Byte GSB" Section 5.3.2: "Device Application Registers" Section 5.4.5: "Data Stuck" Section 6: "SPI registers" Removed Section "Temperature feedback" Added following sections: Section 2.12: "Analog output" Section 3.1.5: "V5V failure" Table 8: "Supply and supply monitoring": VSUV, VREGUV: updated value Table 10: "Voltage regulator V5V": CV5V, Ivsvlim: updated values Table 14: "PWM control": tcc, tb, toc: updated values Table 16: "Digital inputs CTRL1, CTRL2, CTRL3, EN": tstart: added row Table 19: "CSN, SCK, SDI input": RINCSN: updated test condition Updated Table 29: "Device information registers" Updated Table 65: "QFN40L package mechanical data" Updated Section 8: "Order codes"

L99SM81V Revision history

Revision history L99SM81V

Date	Revision	Changes
15-Jun-2017		Updated following sections:
		Section "Features"
		Section 2.6: "Stepping modes and step update"
	4	Section 2.8: "HOLD mode"
		Section 2.9: "Decay modes"
		Section 2.10: "Control pins (CTRLx)"
		Section 2.11: "Digital outputs"
		 Section 2.13: "Motor coil voltage measurement for stall detection"
		Section 3.1: "Supply diagnostics"
		Section 3.2: "Thermal warning and thermal shutdown"
		Section 3.3: "Cross current protection (dead-time)"
		Updated following tables:
		Table 1: "Pin definition and function"
		Table 6: "Thermal data"
		Table 9: "Power on reset"
		Table 10: "Voltage regulator V5V"
		Table 11: "AOUT electrical characteristics"
		• Table 12: "OUTxn outputs (x = A,B; n = 1,2)"
		Table 13: "Charge pump"
		Table 14: "PWM control"
		Table 17: "Coil voltage acquisition"
		Table 21: "SPI timing"
		Table 32: "SPI data length"
		Table 34: "Complete device SPI register table"
		Table 36: "Global Status Register GSR (bit description)"
		Table 40: "Global Configuration Register 1 GCR1 (bit description)"
		Table 44: "Motor Control Register 1 MCR1 (bit description)"
		Table 45: "Motor Control Register 2 MCR2"
		Table 46: "Motor Control Register 2 MCR2 (bit description)"
		Table 47: "Motor Control Register 3 MCR3"
		Table 48: "Motor Control Register 3 MCR3 (bit description)"
		Table 60: "Motor Coil Voltage Low Limit B MCVLLB (bit description)"
		Table 61: "Motor Coil Voltage Low Limit A MCVLLA (bit description)"
		Updated following figures:
		Figure 1: "Block diagram (QFN40L)"
		Figure 2: "Block diagram (PowerSSO-36)"
		Figure 5: "Stepper motor driver application block diagram"
		Figure 14: "Mixed decay"
		Figure 29: "SPI pin description"
		Added
		 Figure 21: "Comparative Auto decay mode 1 vs. Auto decay mode 2"
		Section 7.3: "Marking information"

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